

MIL-M-38510/382A  
22 June 1987  
SUPERSEDING  
MIL-M-38510/382(USAF)  
16 August 1983

MILITARY SPECIFICATION

# MICROCIRCUITS, DIGITAL, BIPOLAR, ADVANCED LOW-POWER SCHOTTKY TTL, D-TYPE LATCHES, CASCADABLE, MONOLITHIC SILICON

This specification is approved for use by all Departments and Agencies of the Department of Defense.

## 1. SCOPE

**1.1 Scope.** This specification covers the detail requirements for monolithic silicon, advanced low-power Schottky TTL, D-type latches, bistable logic microcircuits. Two product assurance classes and a choice of case outlines and lead finishes are provided and are reflected in the complete part number.

1.2 Part number. The part number shall be in accordance with MIL-M-38510, and as specified herein.

### 1.2.1 Device types. The device types shall be as follows:

<u>Device type</u>	<u>Circuit</u>
01	Octal D-type transparent latch with 3-state outputs, cascadable
02	Octal D-type transparent latch with inverted 3-state outputs, cascadable
03	Dual 4-bit D-type transparent latch with 3-state outputs, cascadable
04	Dual 4-bit D-type transparent latch with inverted 3-state outputs, cascadable

1.2.2 Device class. The device class shall be the product assurance level as defined in MIL-M-38510.

1.2.3 Case outline. The case outline shall be designated as follows:

<u>Letter</u>	<u>Case outline (see MIL-M-38510, appendix C)</u>
K	F-6 (24-lead, .375" x .500"), flat package
L	D-9 (24-lead, .250" x 1 1/4"), dual-in-line package
R	D-8 (20-lead, .250" x 1 1/16"), dual-in-line package
S	F-9 (20-lead, .250" x 1/2"), flat package
2	C-2 (20 terminal, .350" x .350") square chip carrier package
3	C-4 (28-terminal, .450" x .450") square chip carrier package

### 1.3 Absolute maximum ratings.

I<sub>7</sub> Must withstand the added P<sub>n</sub> due to short-circuit test (e.g., I<sub>0</sub>).

Beneficial comments (recommendations, additions, deletions) and any pertinent data which may be of use in improving this document should be addressed to: Rome Air Development Center (RBE-2), Griffiss AFB, NY 13441, by using the self-addressed Standardization Document Improvement Proposal (DD Form 1426) appearing at the end of this document or by letter.

#### 1.4 Recommended operating conditions.

Supply voltage ( $V_{CC}$ )	- - - - -	4.5 V dc minimum to 5.5 V dc maximum
Minimum high-level input voltage ( $V_{IH}$ )	- -	2.0 V dc
Maximum low-level input voltage ( $V_{IL}$ )	- -	0.8 V dc
Case operating temperature range ( $T_C$ )	- -	-55°C to +125°C
Input set-up time, $t_{(setup)}$ :		
Device types 01, 02, 03, and 04	- - - -	10 ns minimum
Input hold time, $t_{(hold)}$ :		
Device types 01 and 03	- - - - -	7 ns minimum
Device types 02 and 04	- - - - -	10 ns minimum
Input pulse width, $(t_p)$ :		
Device types 01 and 03 (Enable)	- - - -	10 ns minimum
Device types 02 and 04 (Enable)	- - - -	15 ns minimum
Device type 03 (Clear)	- - - - -	15 ns minimum
Device type 04 (Preset)	- - - - -	15 ns minimum

## 2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this specification to the extent specified herein.

## SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

**STANDARD**

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this specification and the references cited herein (except for associated detail specifications, specification sheets or MS standards), the text of this specification shall take precedence. Nothing in this specification, however, shall supersede applicable laws and regulations unless a specific exemption has been obtained.

### 3. REQUIREMENTS

3.1 Detail specification. The individual item requirements shall be in accordance with MIL-M-38510, and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections and logic diagrams. The terminal connections and logic diagrams shall be as specified on figures 1 and 2 respectively.

2/ When a thermal resistance value is included in MIL-M-38510, appendix C, it shall supersede the value stated herein.

3/ Maximum junction temperature shall not be exceeded except for allowable short duration burn-in screening methods per method 5004 of MIL-STD-883.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions		Device type	Limits		Unit
		-55°C ≤ TC ≤ +125°C			Min	Max	
High-level output voltage	V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V I <sub>OH</sub> = 1.0 mA V <sub>IH</sub> = 2.0 V		A11	2.4		V
Low-level output voltage	V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V I <sub>OL</sub> = 12 mA V <sub>IL</sub> = 0.8 V		A11		0.4	V
Input clamp voltage	V <sub>IC</sub>	V <sub>CC</sub> = 4.5 V I <sub>IN</sub> = -18 mA T <sub>C</sub> = +25°C		A11		-1.5	V
Low-level input current	I <sub>IL</sub>	V <sub>CC</sub> = 5.5 V V <sub>IL</sub> = 0.4 V		A11	0	-200	μA
High-level input current	I <sub>IH1</sub>	V <sub>CC</sub> = 5.5 V V <sub>IH</sub> = 2.7 V		A11		20	μA
	I <sub>IH2</sub>	V <sub>CC</sub> = 5.5 V V <sub>IH</sub> = 7.0 V		A11		110	μA
Output current 1/	I <sub>O</sub>	V <sub>CC</sub> = 5.5 V V <sub>O</sub> = 2.25 V		01	-15	-112	mA
				02,03,04	-15	-110	
Output current, high level, outputs off	I <sub>OZH</sub>	V <sub>CC</sub> = 5.5 V V <sub>OH</sub> = 2.7 V		A11		20	μA
Output current, low level, outputs off	I <sub>OZL</sub>	V <sub>CC</sub> = 5.5 V V <sub>OH</sub> = 0.4 V		A11		-20	μA
Supply current, outputs high	I <sub>CCH</sub>	V <sub>CC</sub> = 5.5 V	V <sub>IN</sub> = 5.0 V	01		19	
				03		21	
			V <sub>IN</sub> = 0 V	02		17	
				04		21	
Supply current, outputs low	I <sub>CCL</sub>	V <sub>CC</sub> = 5.5 V	V <sub>IN</sub> = 0 V	01		24	mA
				03		29	
			V <sub>IN</sub> = 5.0 V	02		24	
				04		29	
Supply current, outputs disabled	I <sub>CCZ</sub>	V <sub>CC</sub> = 5.5 V V <sub>OC</sub> = 5.0 V	V <sub>IN</sub> = 0 V	01		27	
				03		31	
			V <sub>IN</sub> = 5.5 V	02		27	
				04		31	

See footnote at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55^{\circ}\text{C} \leq T_C \leq +125^{\circ}\text{C}$	Device type	Limits	Unit	
				Min	Max	
Propagation delay time to low level (clear or preset to output)	tPHL1	$V_{CC} = 5.0\text{ V}$ $C_L = 50\text{ pF} \pm 10\%$ $R_L = 500\Omega$	03,04	6	24	ns
Propagation delay time to high level (enable to output)	tPLH2		01	8	27	ns
			02,03	8	29	
			04	8	31	
Propagation delay time to low level (enable to output)	tPHL2		01	8	20	ns
			02,03, 04	8	22	
Propagation delay time to high level (data to output)	tPLH3		01,03	2	15	ns
			02	3	21	
			04	3	23	
Propagation delay time to low level (data to output)	tPHL3		01,03	2	15	ns
			02,04	3	15	
Output control on to high-level output	tpZH		A11	4	21	ns
Output control on to low-level output	tpZL		A11	4	21	ns
High-level output to output control off	tPHZ		01	2	12	ns
			02,03,04	2	10	
Low-level output to output control off	tPLZ		01	3	18	ns
			02,04	3	15	
			03	2	15	

1/ The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current,  $I_{OS}$ .

3.2.2 Truth tables. The truth tables shall be as specified on figure 3.

3.2.3 Schematic circuits. Schematic circuits shall be submitted to the preparing activity prior to inclusion of a manufacturer's device in the specification and shall be submitted to the qualifying activity and agent activity (DESC-ECS) as a prerequisite for qualification. All qualified manufacturers' schematics shall be maintained by the agent activity and will be available upon request.

3.2.4 Case outlines. The case outlines shall be as specified in MIL-M-38510 and 1.2.3 herein.

3.3 Lead material and finish. The lead material and finish shall be in accordance with MIL-M-38510 (see 6.4).

3.4 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range.

3.5 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (see table III)	
	Class S devices	Class B devices
Interim electrical parameters (method 5004)	1	1
Final electrical tests (method 5004)	1*, 2, 3, 7, 9, 10, 11	1*, 2, 3, 7, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11	1, 2, 3, 7, 9
Group B electrical tests (method 5005) subgroup 5	1, 2, 3, 9, 10, 11	N/A
Group C end-point electrical parameters (method 5005)	N/A	1, 2, 3
Additional electrical subgroups for group C periodic inspections	N/A	10, 11
Group D end-point electrical parameters (method 5005)	1, 2, 3	1, 2, 3

\*PDA applies to subgroup 1 (see 4.2c).

3.6 Marking. Marking shall be in accordance with MIL-M-38510.

3.7 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 10 (see MIL-M-38510, appendix E).

#### 4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-M-38510 and MIL-STD-883, methods 5005 and 5007, as applicable, except as modified herein.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test (method 1015 of MIL-STD-883).

(1) Test condition D or E, using the circuit shown on figure 4, or equivalent.

(2)  $T_A = +125^\circ\text{C}$  minimum.

- b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical test parameters prior to burn-in are optional at the discretion of the manufacturer.
- c. The percent defective allowable (PDA) shall be as specified in MIL-M-38510.

4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-M-38510. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4 Quality conformance inspection. Quality conformance inspection shall be in accordance with MIL-M-38510 and as specified herein. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table I of method 5005 of MIL-STD-883 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 shall be omitted.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of method 5005 of MIL-STD-883. Electrical parameters shall be as specified in table II herein.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table III of method 5005 of MIL-STD-883 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Subgroups 3 and 4 shall be added to the group C inspection requirements for class B devices and shall consist of the tests, conditions, and limits specified for subgroups 10 and 11 of group A.
- c. Steady-state life test (see method 1005 of MIL-STD-883):
  - (1) Test condition D or E, using the circuit shown on figure 4, or equivalent.
  - (2)  $T_A = +125^\circ\text{C}$  minimum.
  - (3) Test duration: 1,000 hours, except as permitted by appendix B of MIL-M-38510, and method 1005 of MIL-STD-883.

4.4.4 Group D inspection. Group D inspection shall be in accordance with table IV of method 5005 of MIL-STD-883. End-point electrical tests shall be as specified in table II herein.

4.5 Methods of inspection. Methods of inspection shall be specified as follows.

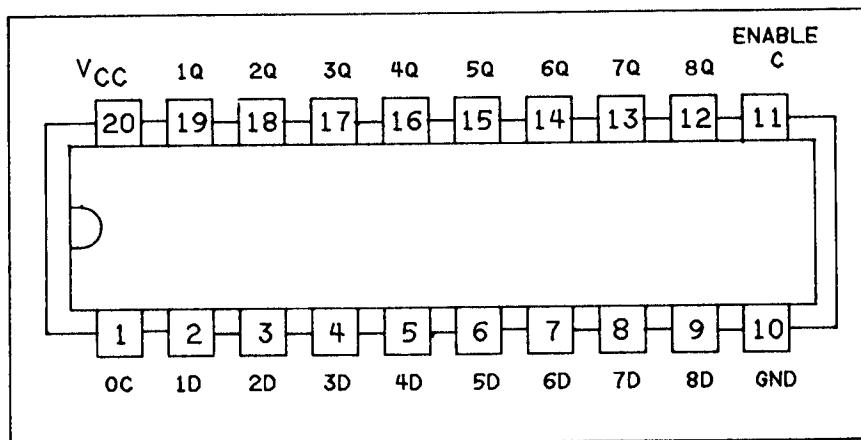
4.5.1 Voltage and current. All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional and positive when flowing into the referenced terminal.

## 5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be as specified in MIL-M-38510.

Device type 01

Cases R and S



Device type 01

Case 2

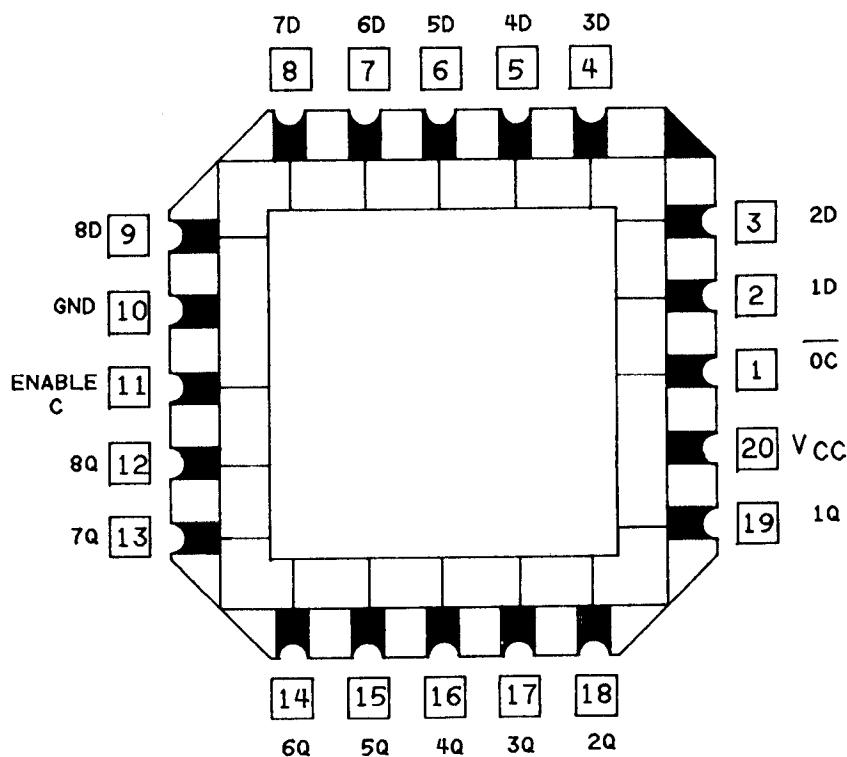


FIGURE 1. Terminal connections.

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Device type 02  
Cases R and S

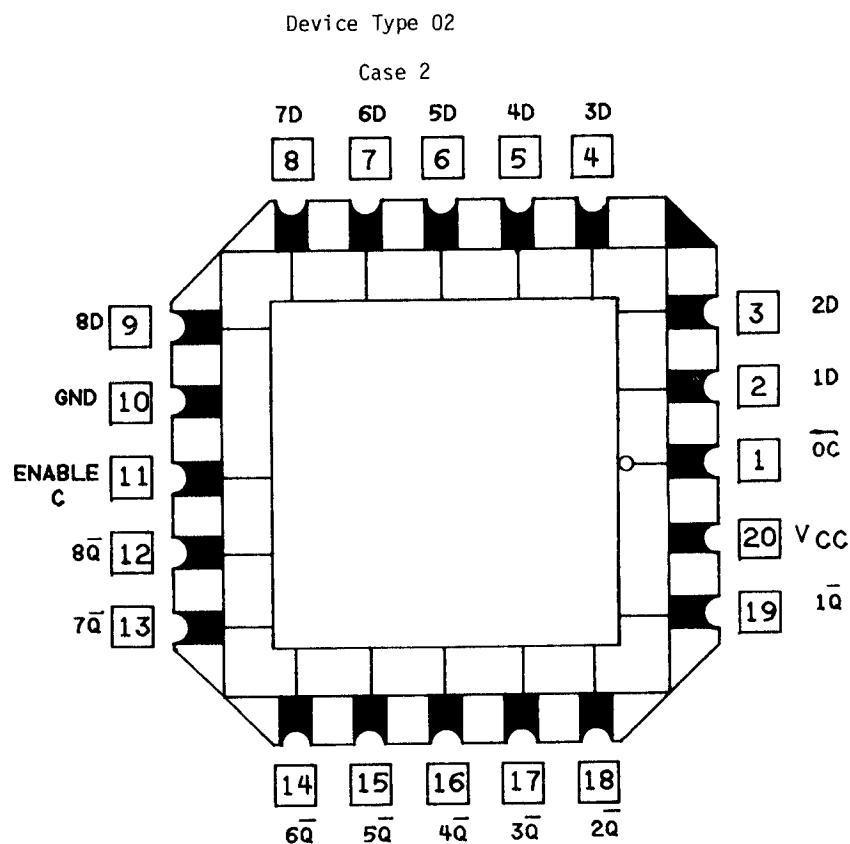
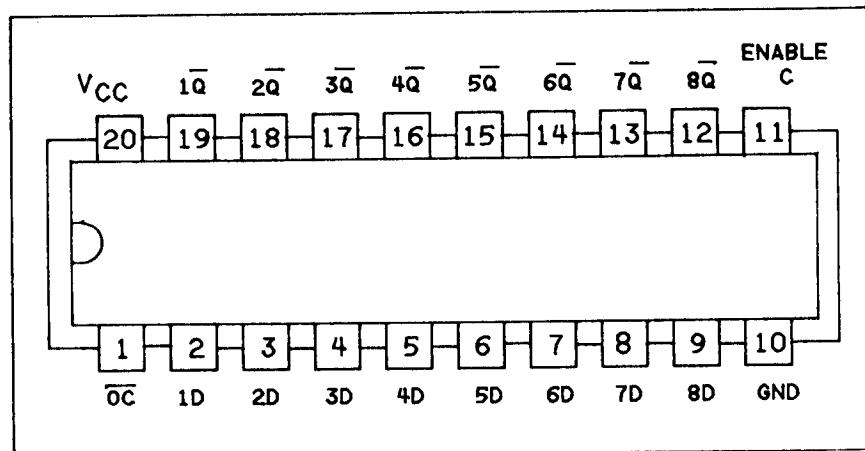
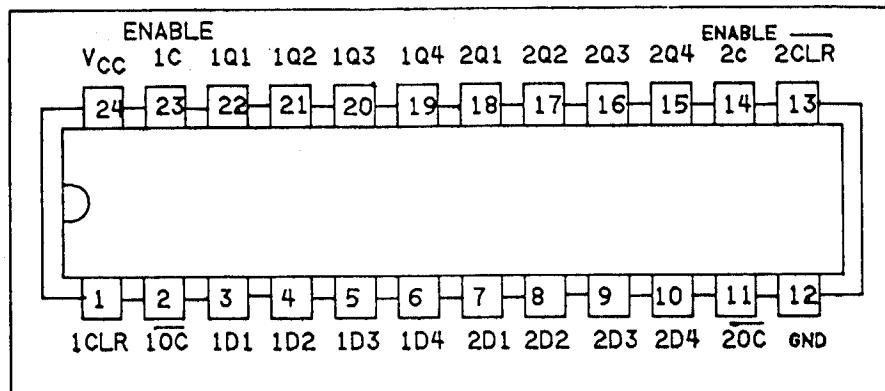


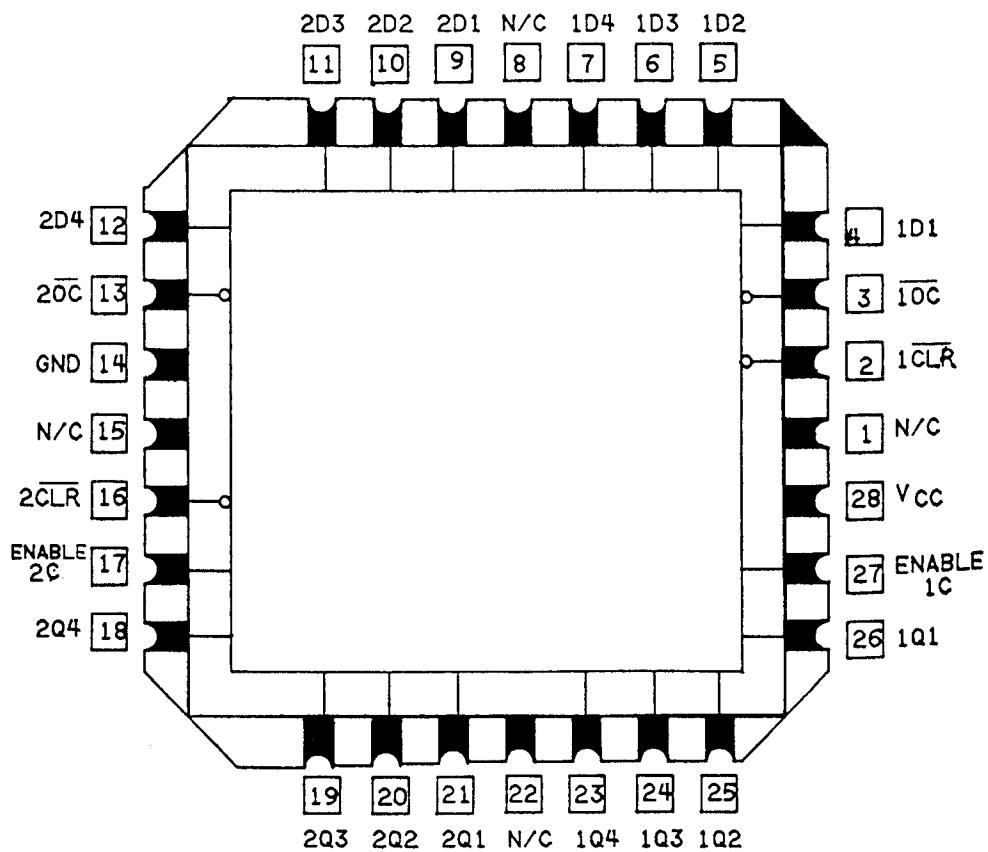
FIGURE 1. Terminal connections - Continued.

Device type 03

Cases K and L

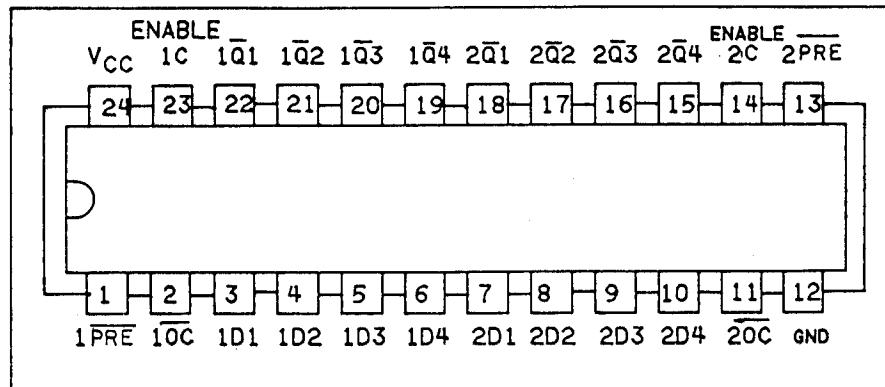
Device type 03

Case 3

FIGURE 1. Terminal connections - Continued.

Device type 04

Cases K and L



Device type 04

Case 3

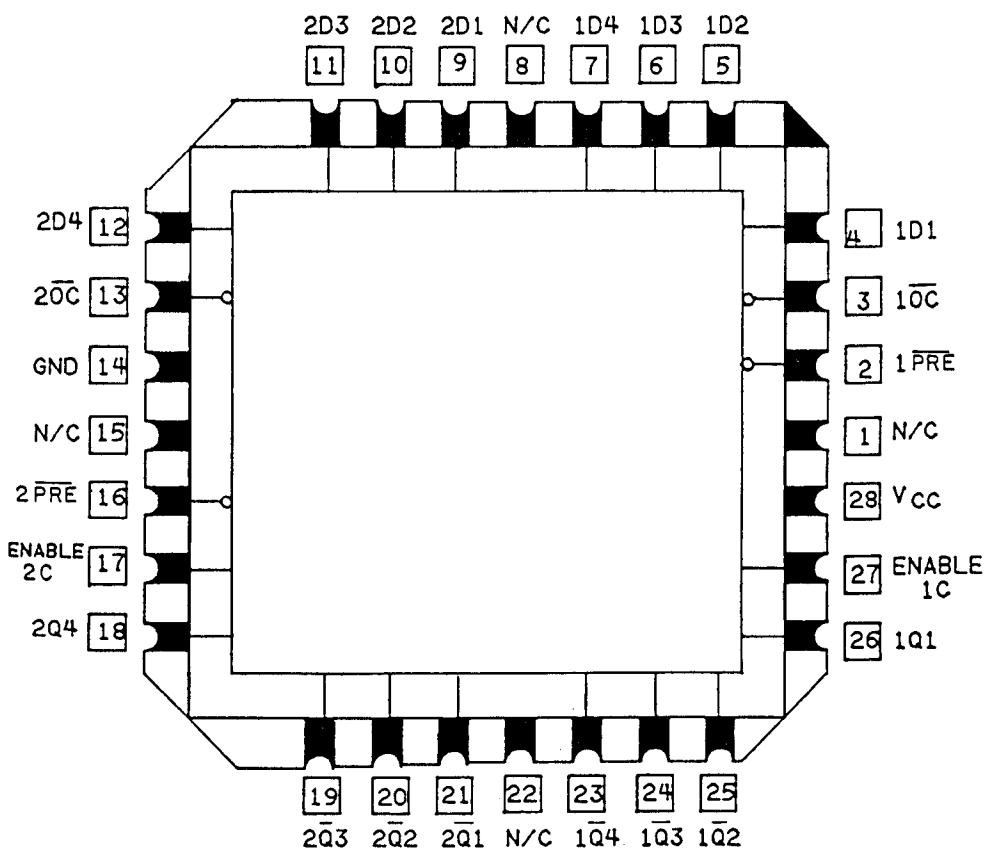
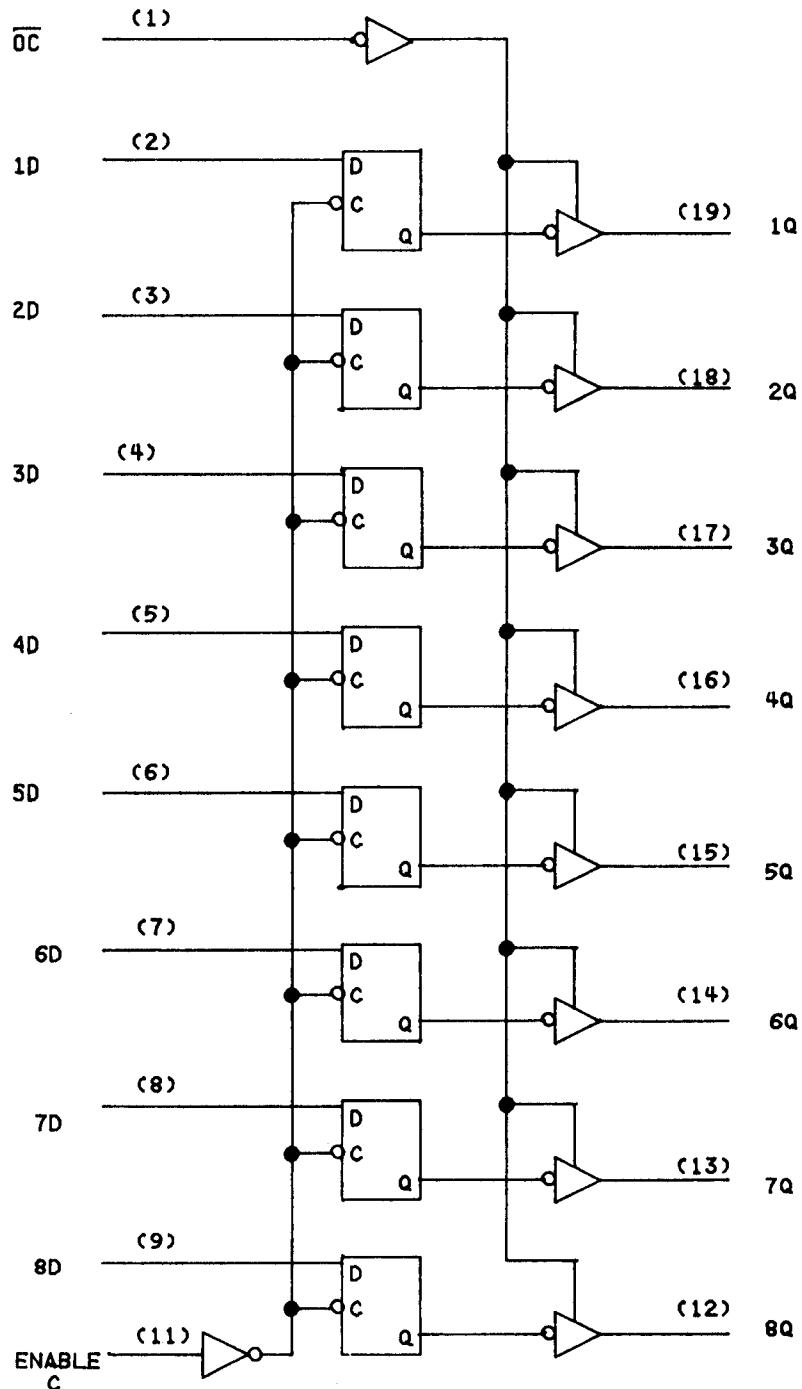
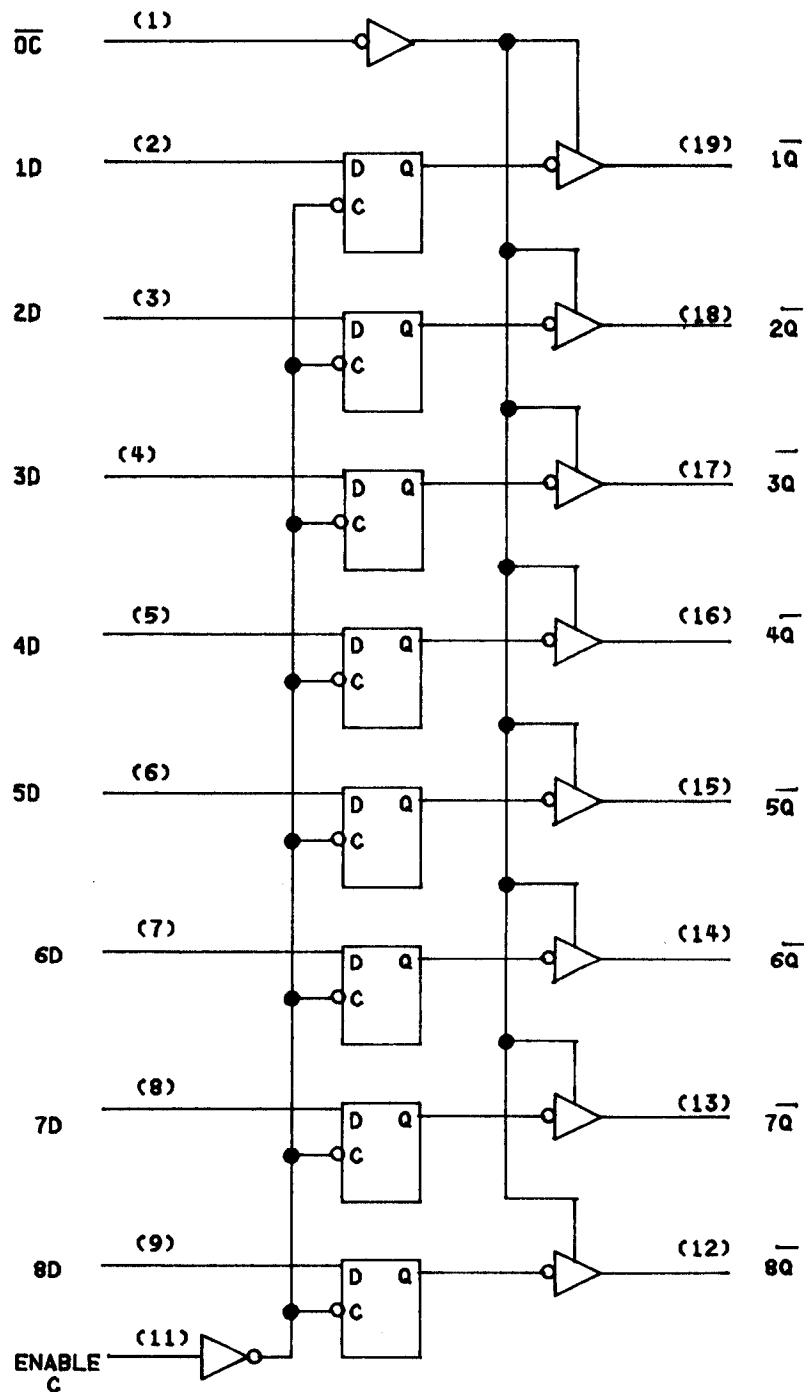


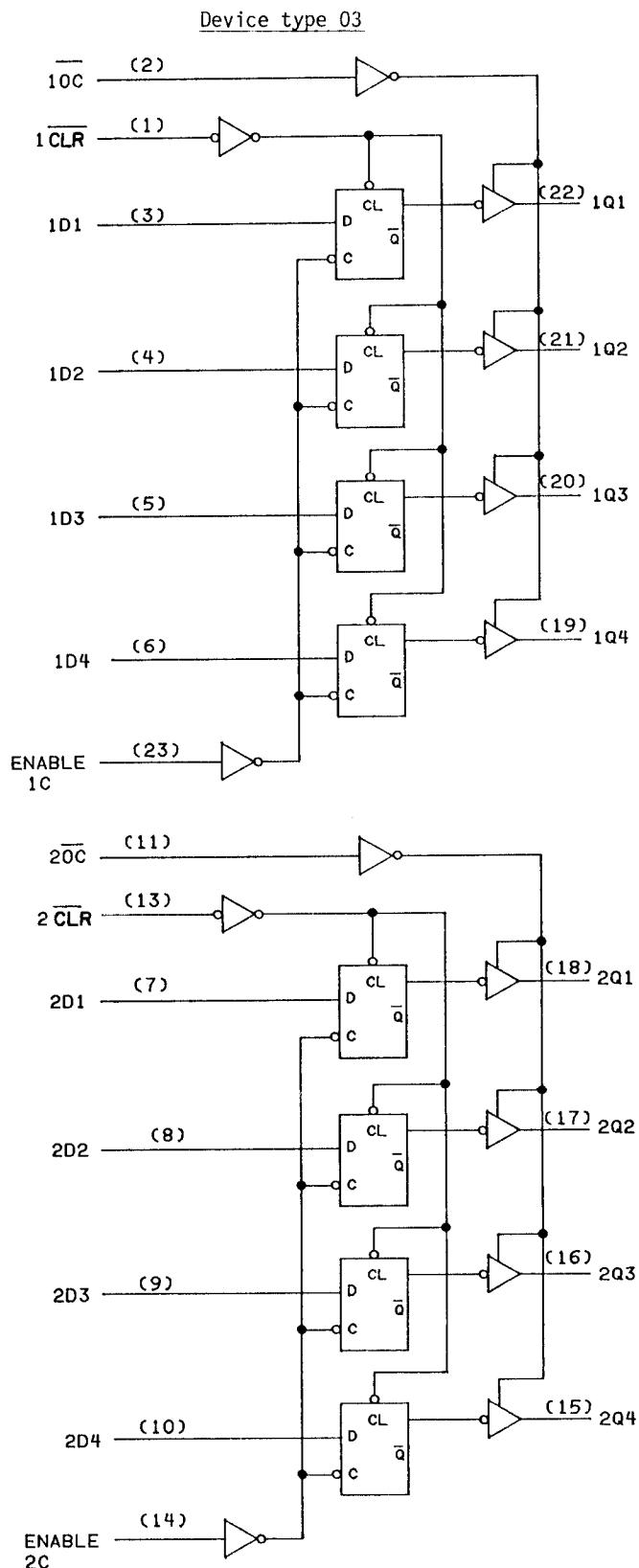
FIGURE 1. Terminal connections - Continued.

## Device type 01

FIGURE 2. Logic diagrams.

Device type 02

FIGURE 2. Logic diagrams - Continued.

FIGURE 2. Logic diagrams - Continued.

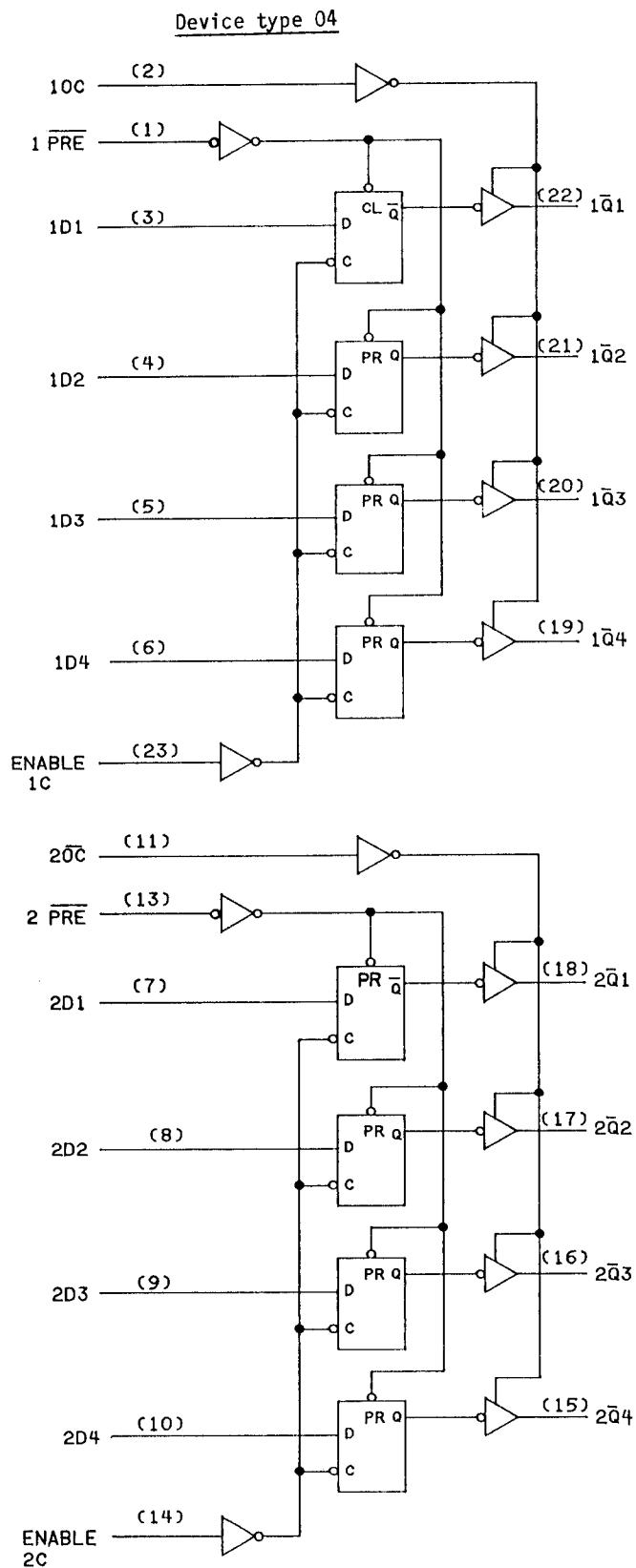


FIGURE 2. Logic diagrams - Continued.

Device type 01

Output control	Enable	Data	Output
$\bar{OC}$	EN C	D	Q
H	X	X	Z
L	L	X	$Q_0$
L	H	L	L
L	H	H	H

Device type 02

Output control	Enable	Data	Output
$\bar{OC}$	EN C	D	$\bar{Q}$
H	X	X	Z
L	L	X	$\bar{Q}_0$
L	H	L	H
L	H	H	L

Device type 03

Output control	Clear	Enable	Data	Output
$\bar{OC}$	$\bar{CLR}$	EN C	D	Q
H	X	X	X	Z
L	L	X	X	L
L	H	L	X	$Q_0$
L	H	H	L	L
L	H	H	H	H

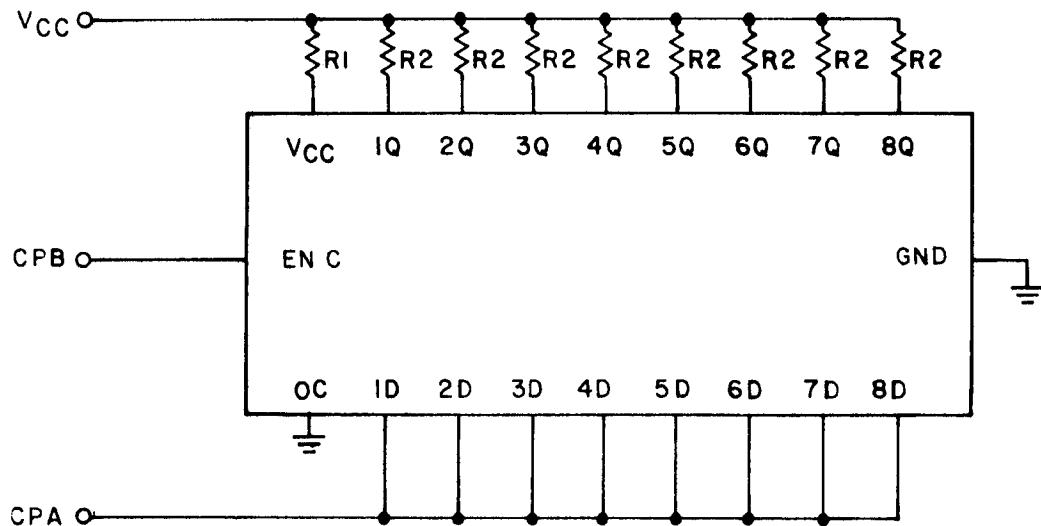
Device type 04

Output control	Preset	Enable	Data	Output
$\bar{OC}$	$\bar{PRE}$	EN C	D	$\bar{Q}$
H	X	X	X	Z
L	L	X	X	L
L	H	L	X	$Q_0$
L	H	H	L	H
L	H	H	H	L

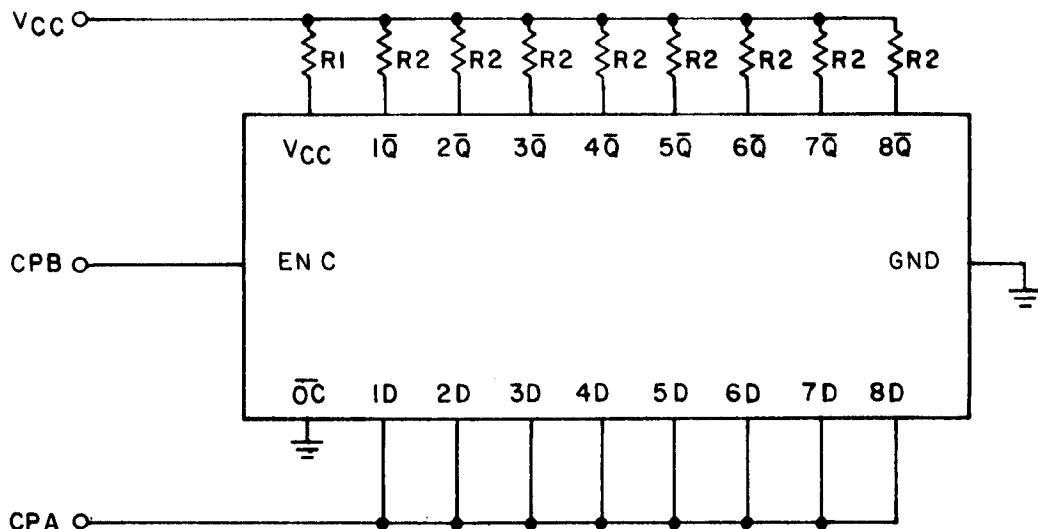
H = High level (steady state)  
 L = Low level (steady state)  
 Z = High impedance state  
 X = Irrelevant  
 $Q_0$  = The level of Q or  $\bar{Q}$  before the indicated input conditions were established.

FIGURE 3. Truth tables.

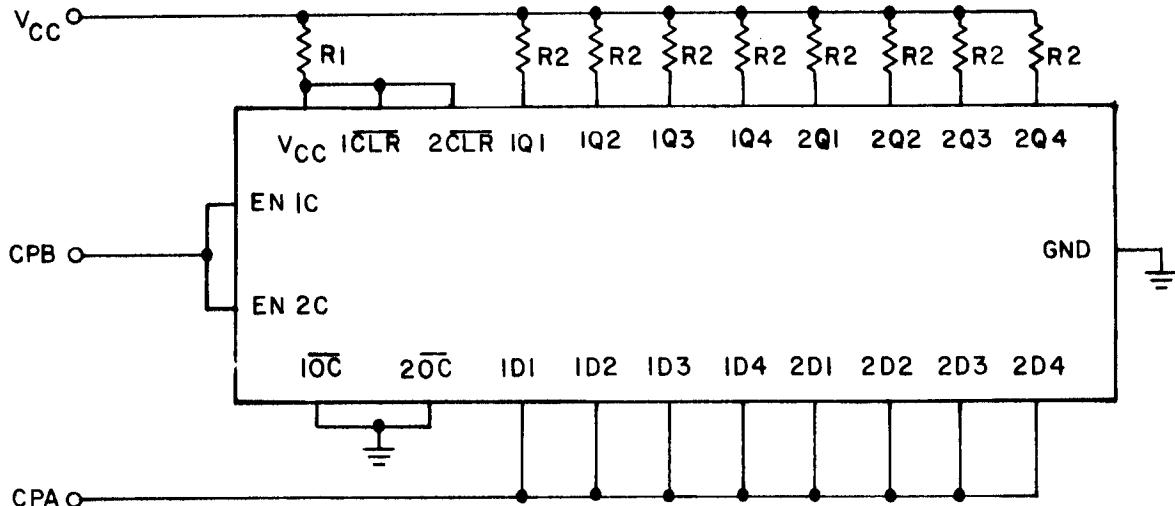
Device type 01



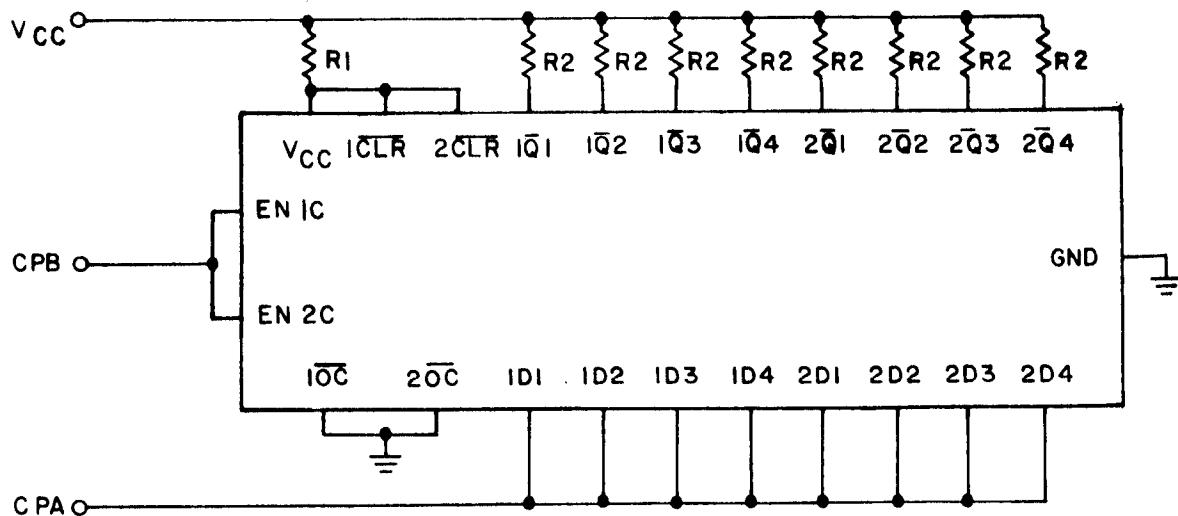
Device type 02

FIGURE 4. Burn-in and life test circuits.

Device type 03

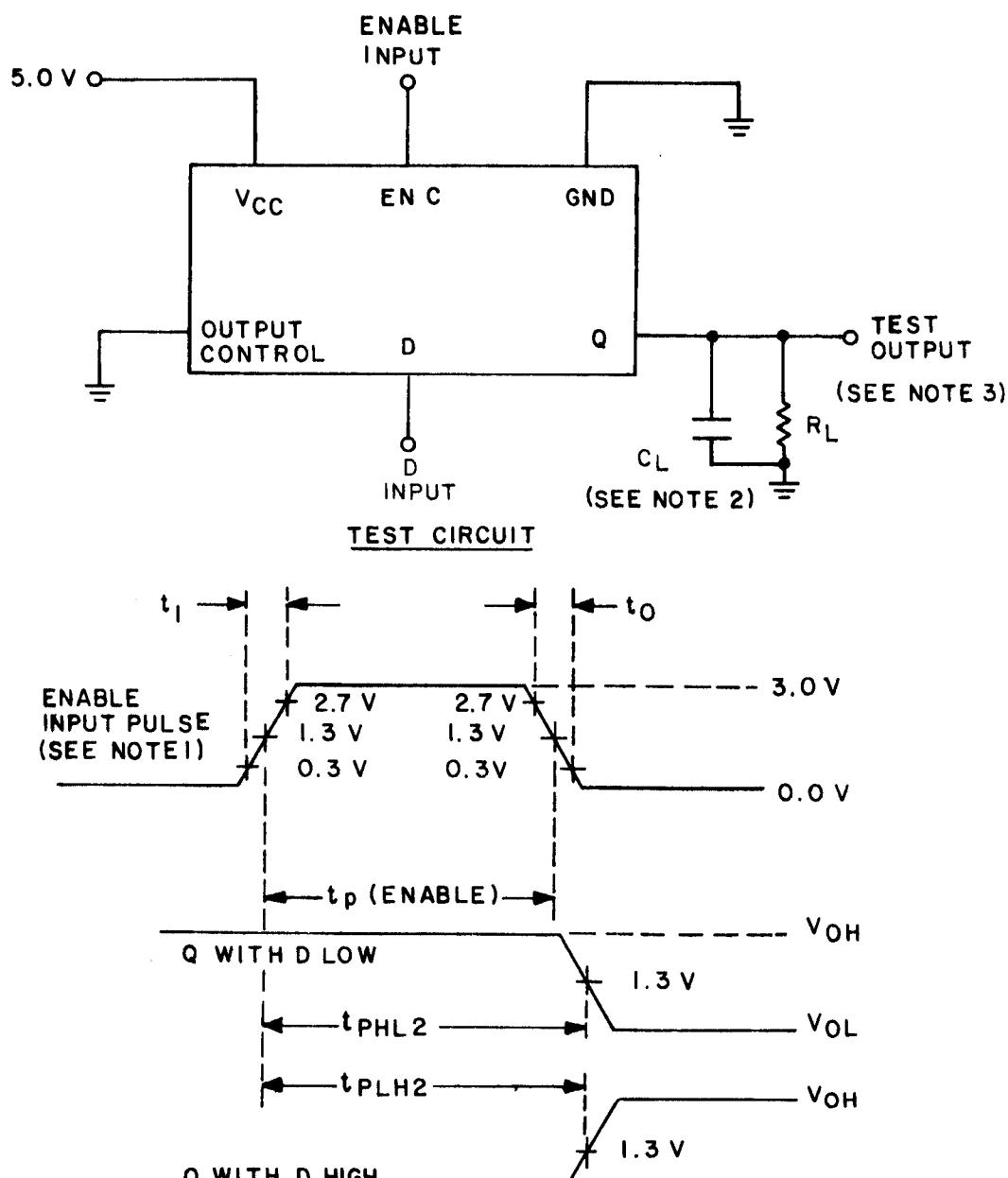


Device type 04

**NOTES:**

1. CPA = 100 kHz 50% square wave; duty cycle = 50 ±15%; V<sub>IL</sub> = -0.5 V minimum to 0.7 V maximum; V<sub>IH</sub> = 2.0 V minimum to 5.5 V maximum.
2. CPB is same as CPA, synchronized with CPA, except 50 kHz ±50% square wave.
3. R<sub>2</sub> = 470Ω ±5%.
4. R<sub>1</sub> and V<sub>CC</sub> shall be chosen to insure 5.0 V minimum is present at device V<sub>CC</sub> terminal.

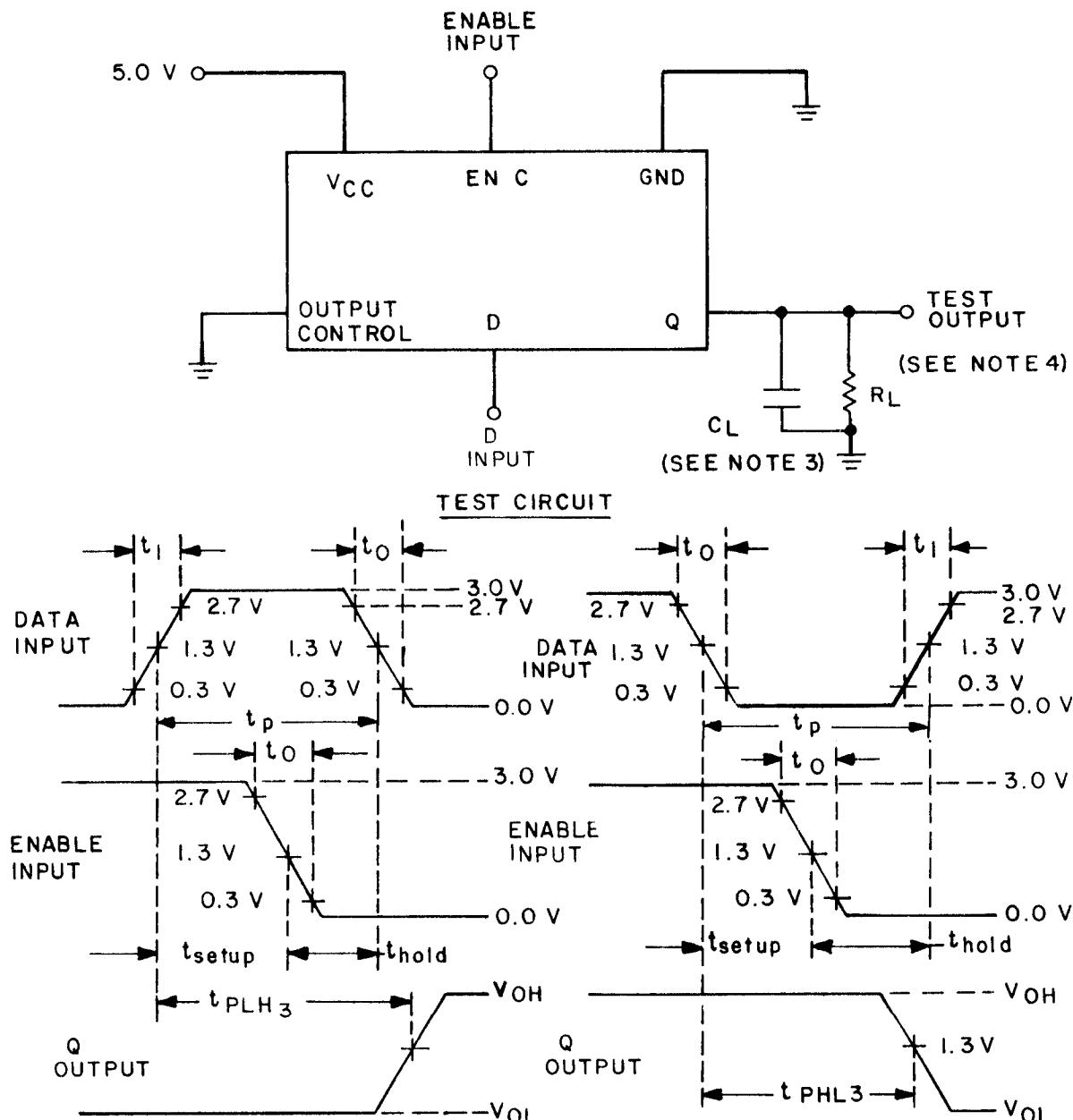
FIGURE 4. Burn-in and life test circuits - Continued.

VOLTAGE WAVEFORMS

## NOTES:

1. Enable input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_p$  (enable) = 10 ns; PRR  $\leq 1$  MHz;  $Z_{OUT} \leq 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = 499\Omega \pm 1\%$ .

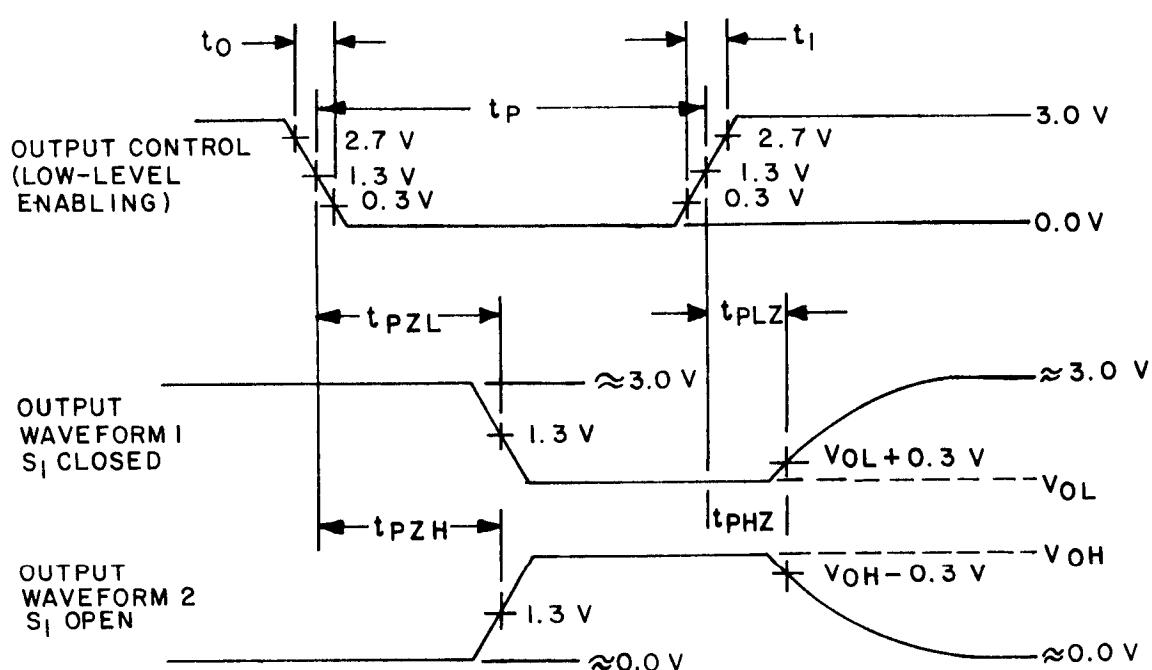
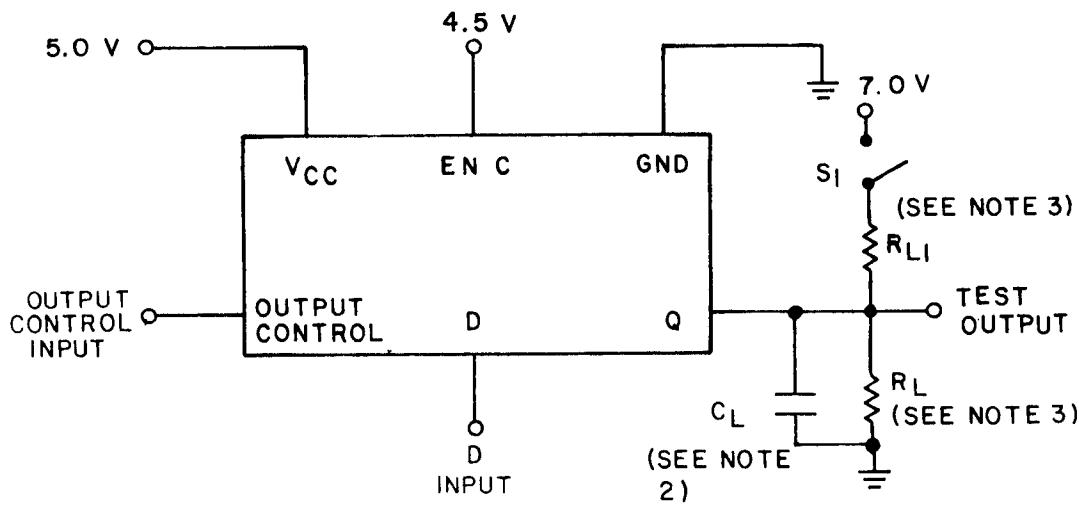
FIGURE 5. Enable switching test circuit and waveforms (device type 01).



## NOTES:

1. Enable input pulse characteristics:  $t_0 = 6 \pm 1.5$  ns; PRR  $\leq 1$  MHz;  $Z_{OUT} \approx 50\Omega$ .
2. D input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_{setup} = 10$  ns;  $t_{hold} = 7$  ns;  $t_p = 17$  ns;  $Z_{OUT} \approx 50\Omega$ .
3.  $C_L = 50$  pF 10% (including jig and probe capacitance).
4.  $R_L = 499\Omega \pm 1\%$ .

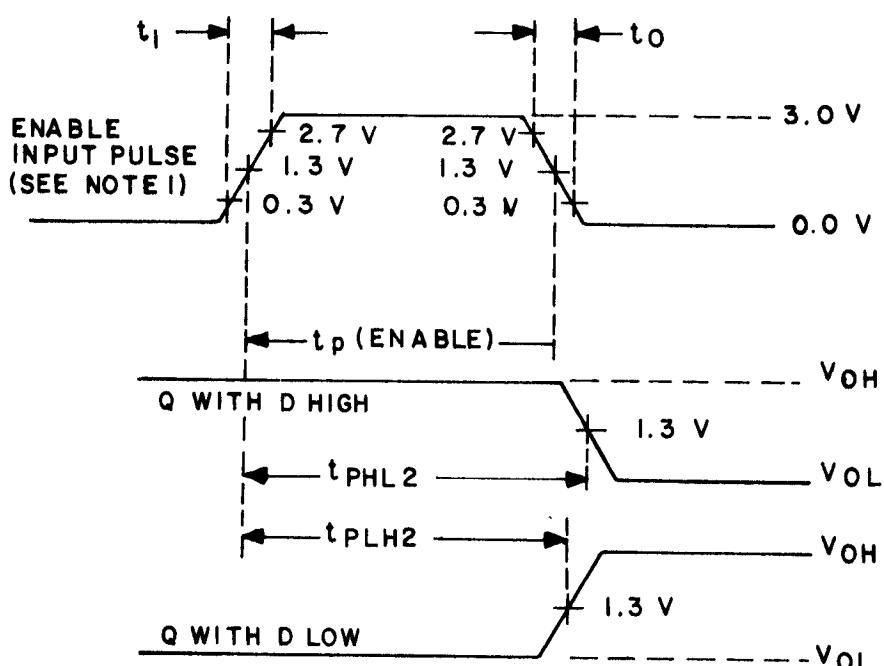
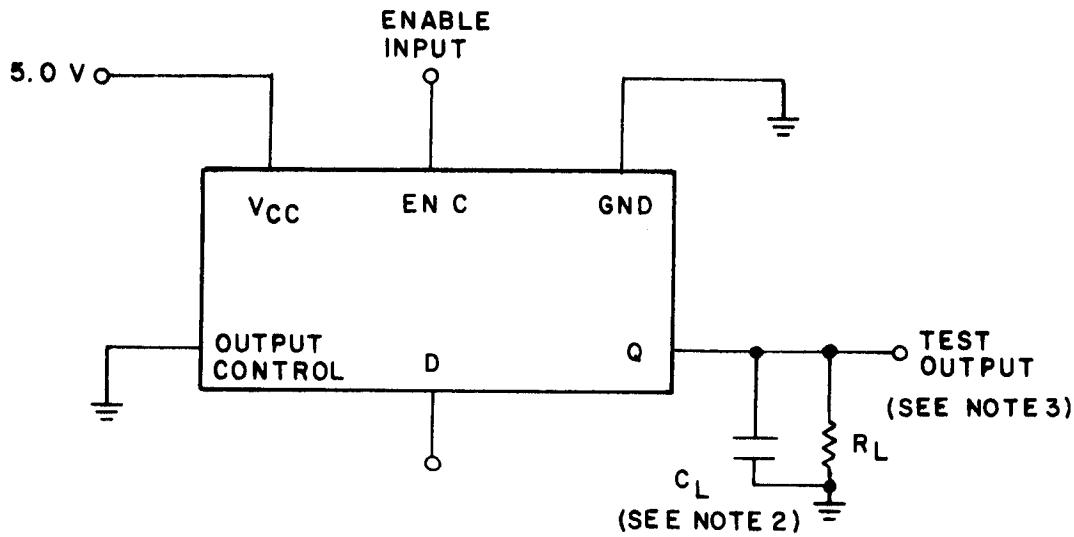
FIGURE 5. Data switching test circuit and waveforms (device type 01).

VOLTAGE WAVEFORMS

## NOTES:

1. Output control input pulse characteristics:  $t_0 = t_1 = 6 \pm 1.5 \text{ ns}$ ;  $t_p \geq 200 \text{ ns}$ ;  $\text{PRR} \leq 1 \text{ MHz}$ ;  $Z_{\text{OUT}} \approx 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = R_{L1} = 499\Omega \pm 1\%$ .

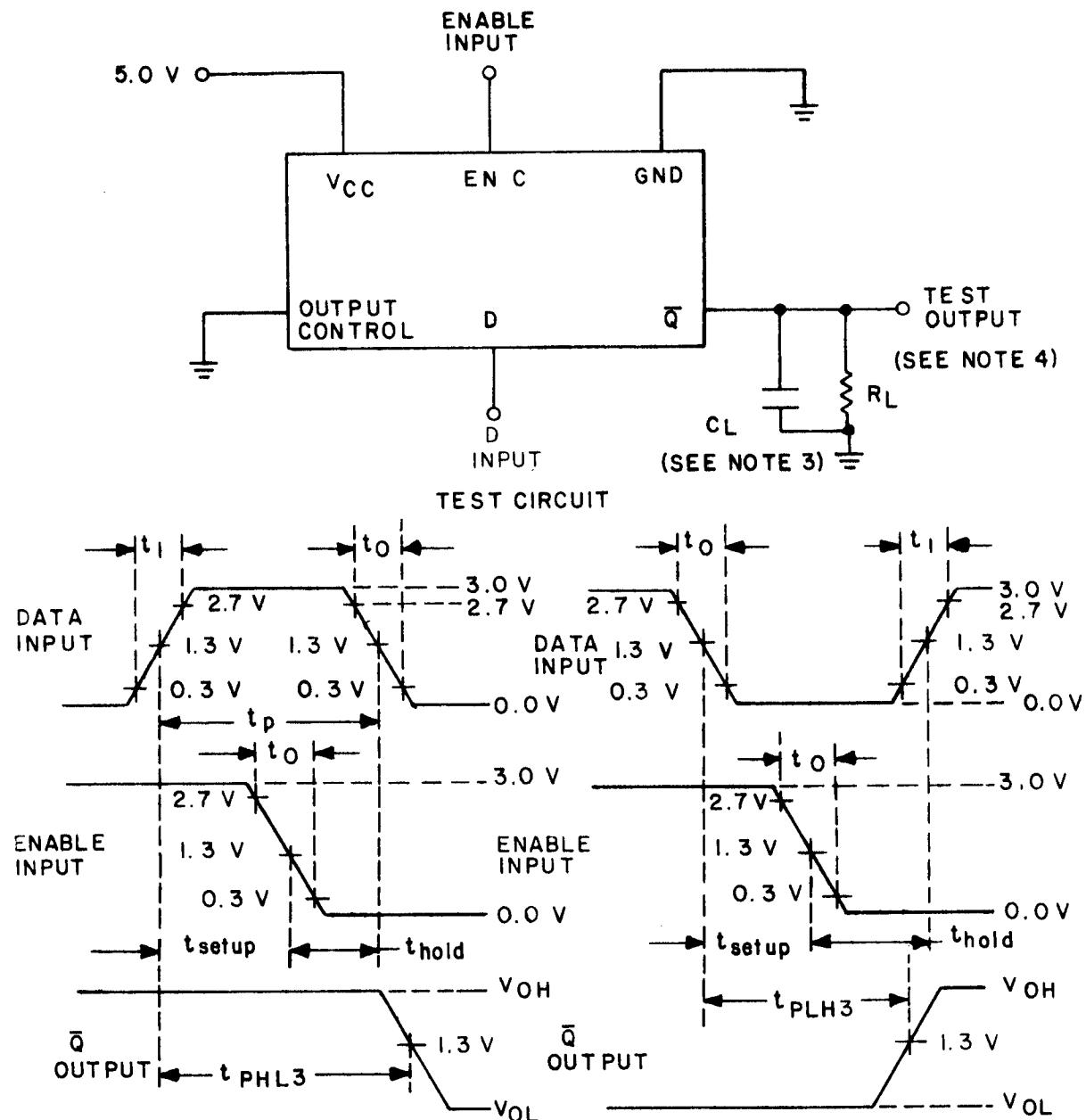
FIGURE 5. Tri-state switching test circuit and waveforms for device type 01.

VOLTAGE WAVEFORMS

## NOTES:

1. Enable input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5 \text{ ns}$ ;  $t_p (\text{enable}) = 15 \text{ ns}$ ;  $\text{PRR} \leq 1 \text{ MHz}$ ;  $Z_{\text{OUT}} \approx 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = 499\Omega \pm 1\%$ .

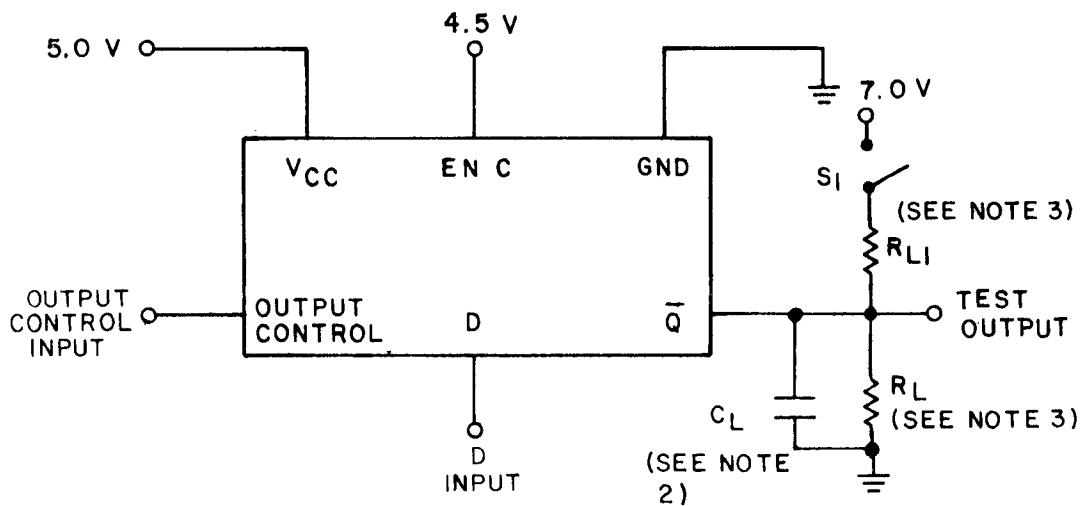
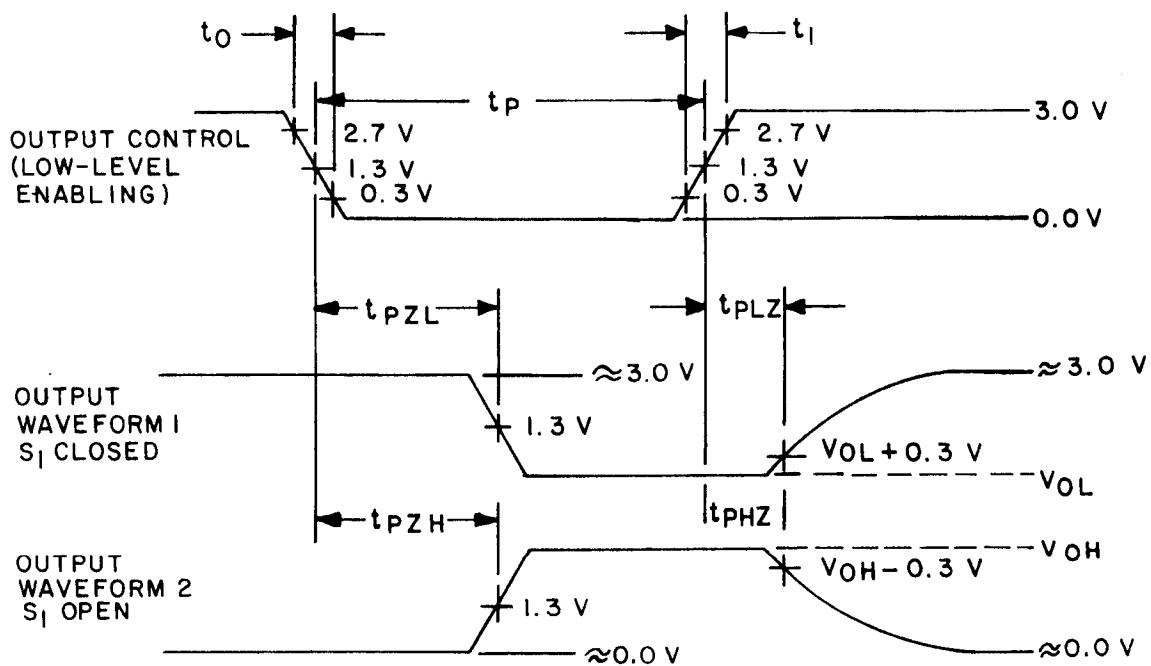
FIGURE 5. Enable switching test circuit and waveforms (device type 02).



**NOTES:**

1. Enable input pulse characteristics:  $t_0 = 6 \pm 1.5$  ns;  $t_p = 15$  ns; PRR  $\leq 1$  MHz,  $Z_{OUT} \geq 50\Omega$ .
  2. D input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_{setup} = 10$  ns;  $t_{hold} = 10$  ns;  $t_p \geq 20$  ns; PRR is 50% of enable PRR,  $Z_{OUT} \geq 50\Omega$ .
  3.  $C_L = 50$  pF  $\pm 10\%$  (including jig and probe capacitance).
  4.  $R_L = 499\Omega \pm 1\%$ .

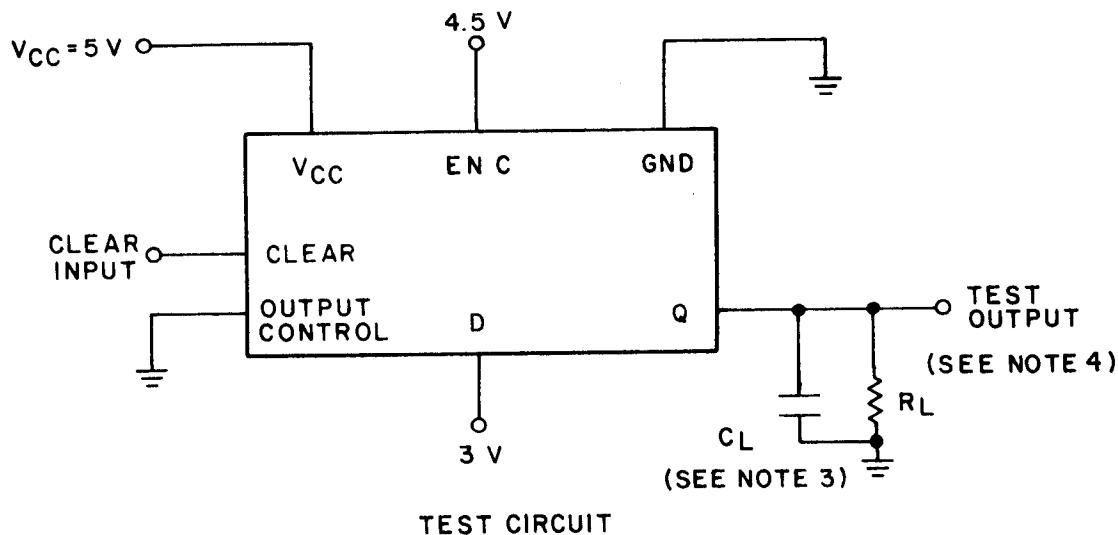
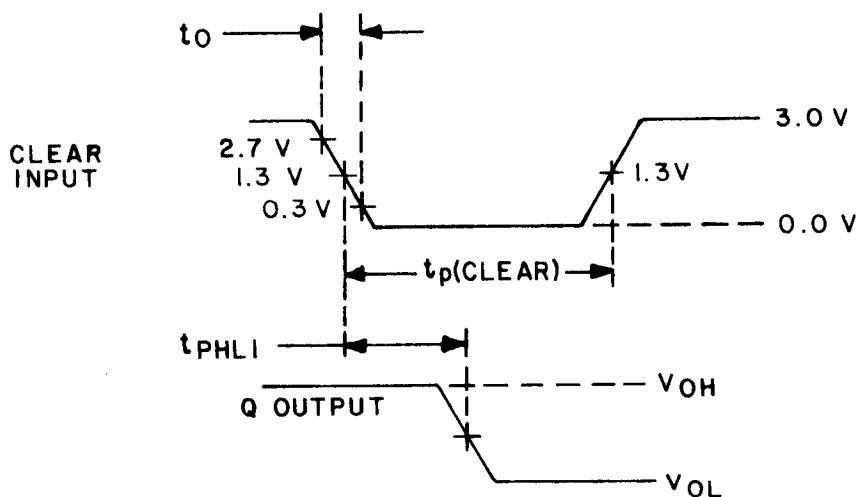
FIGURE 5. Data switching test circuit and waveforms (device type 02).

TEST CIRCUITVOLTAGE WAVEFORMS

## NOTES:

1. Output control input pulse characteristics:  $t_0 = t_1 = 6 \pm 1.5 \text{ ns}$ ;  $t_p \geq 200 \text{ ns}$ ;  $\text{PRR} \leq 1 \text{ MHz}$ ;  $Z_{\text{OUT}} \approx 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = R_{L1} = 499\Omega \pm 1\%$ .

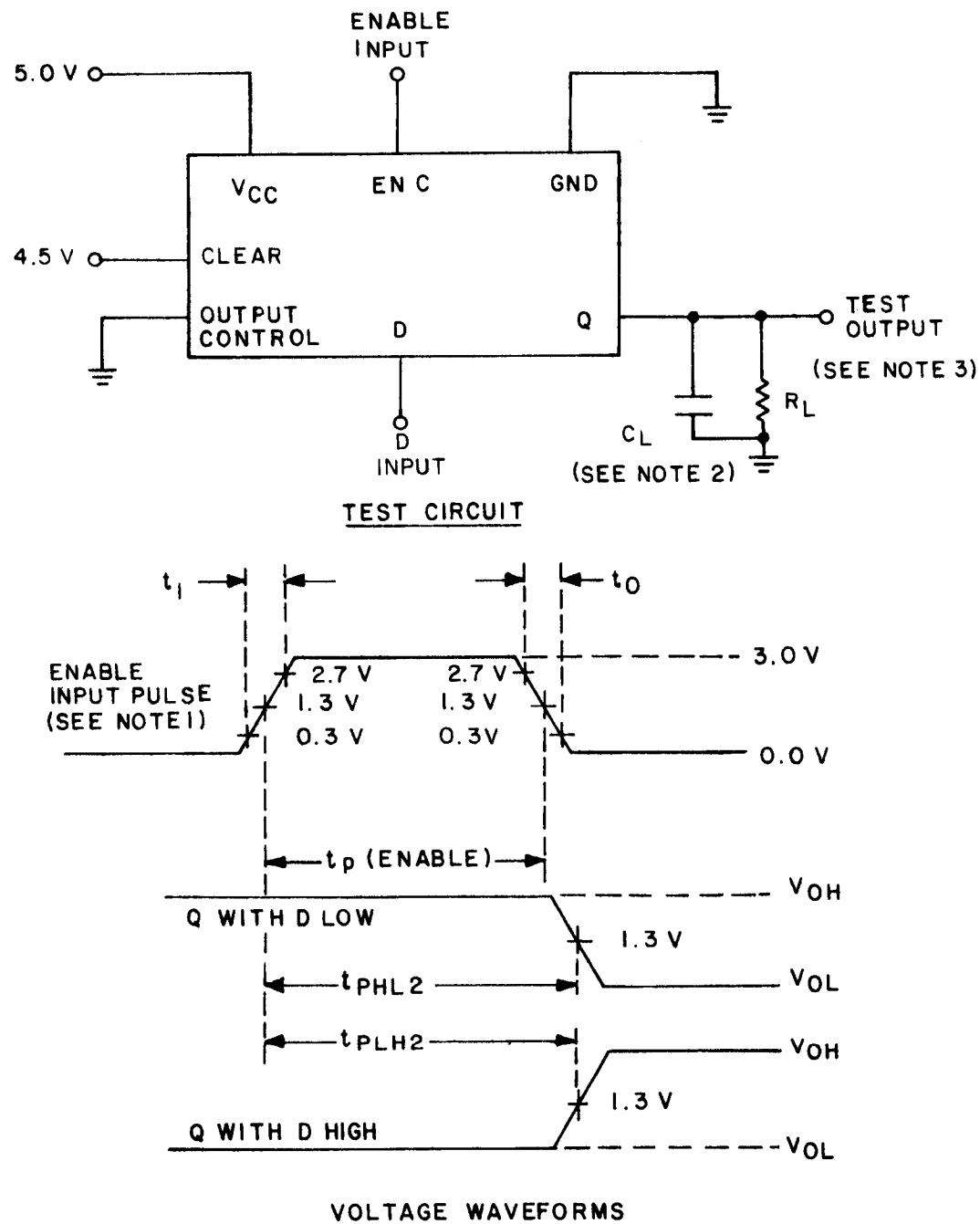
FIGURE 5. Tri-state switching test circuit and waveforms for device type 02.

TEST CIRCUITVOLTAGE WAVEFORM

## NOTES:

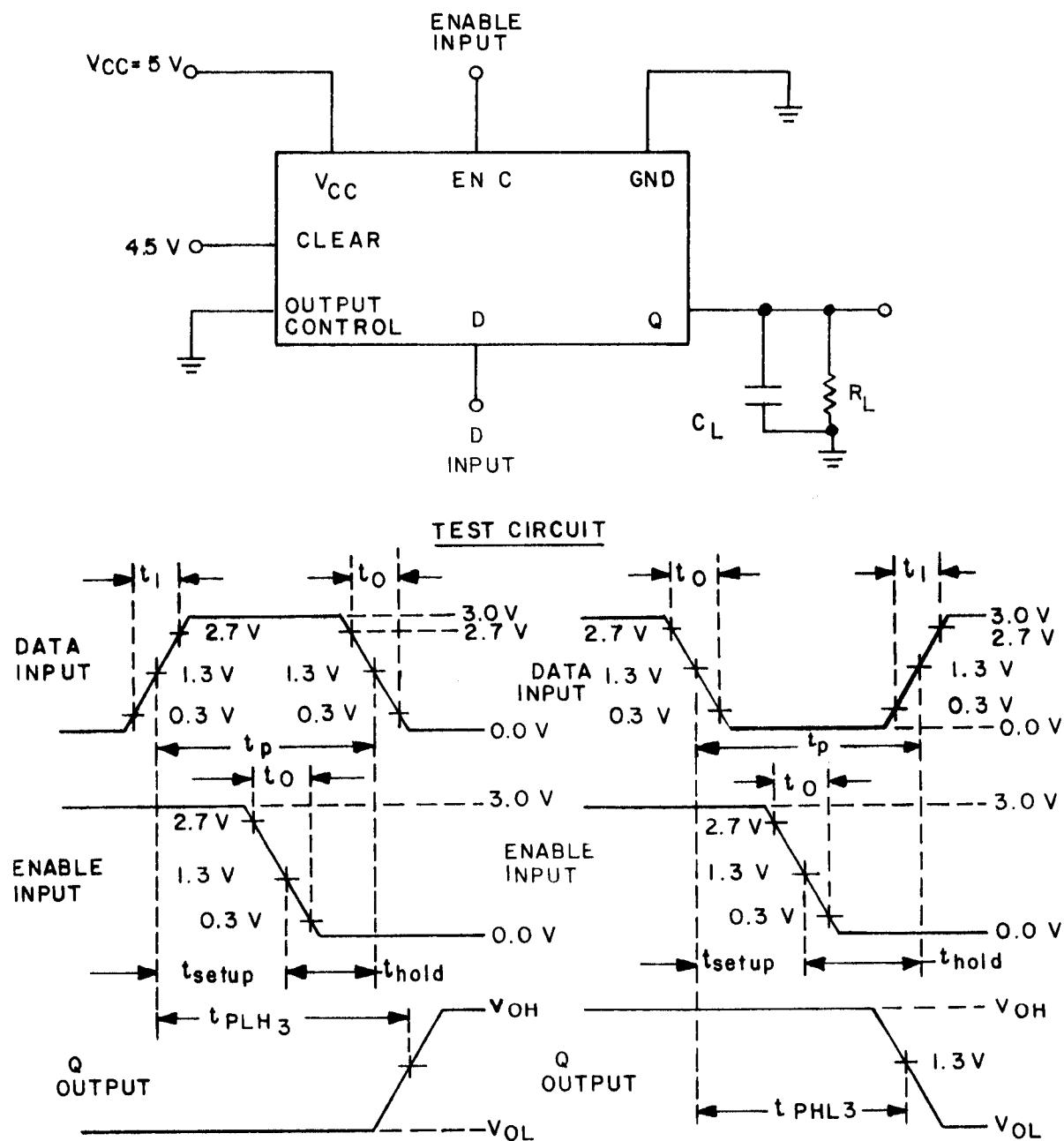
1. Clear input dominates regardless of state of D input.
2. Clear input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5 \text{ ns}$ ;  $t_p(\text{clear}) = 15 \text{ ns}$ ; PRR  $\leq 1 \text{ MHz}$ ,  $Z_{OUT} \geq 50\Omega$ .
3.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
4.  $R_L = 499\Omega \pm 1\%$ .

FIGURE 5. Clear switching test circuit and waveforms (device type 03).

**NOTES:**

1. Enable input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_p$  (enable) = 10 ns; PRR  $\leq$  1 MHz;  $Z_{OUT} \leqq 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = 499\Omega \pm 1\%$ .

FIGURE 5. Enable switching test circuit and waveforms (device type 03).

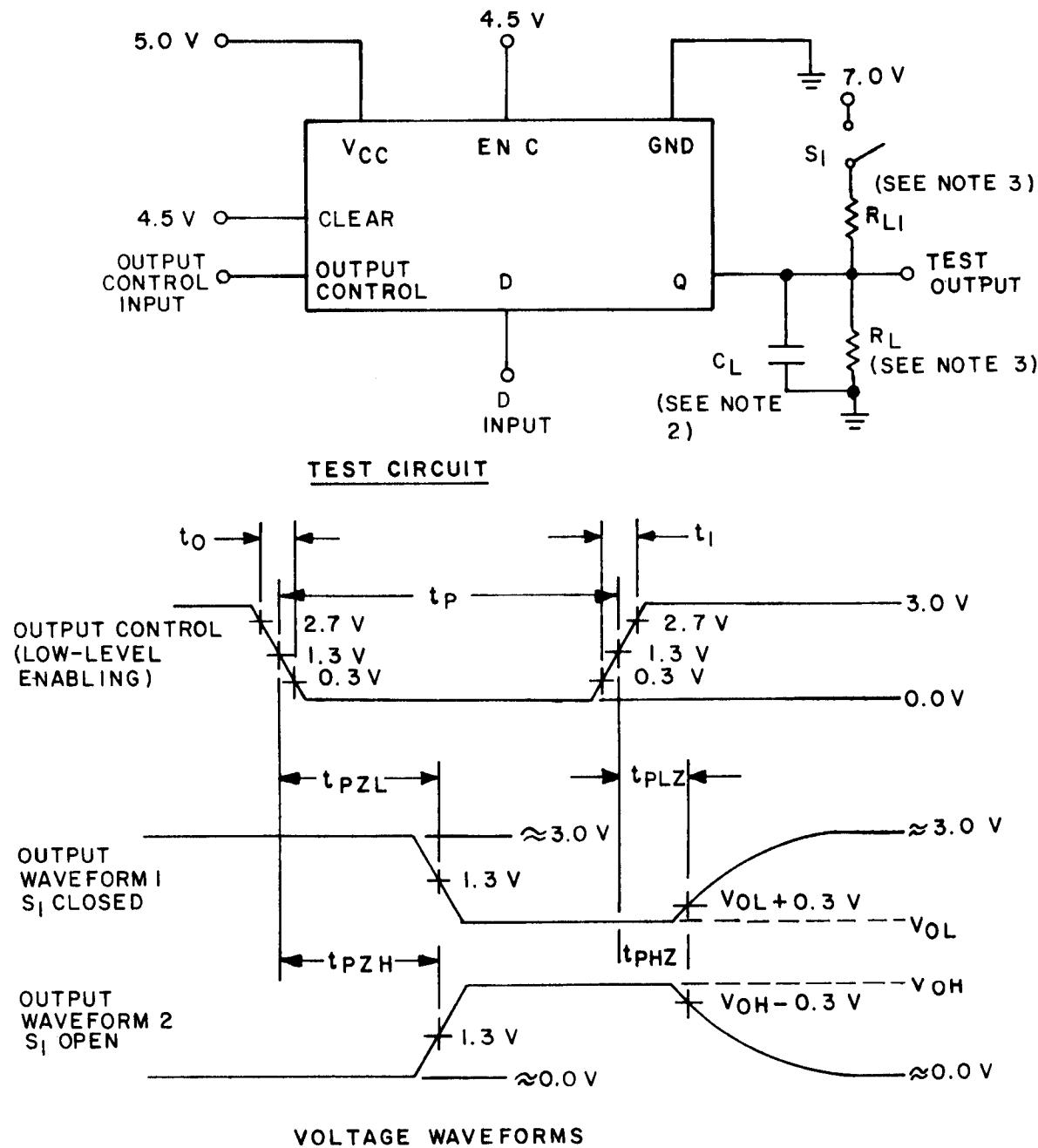


## **NOTES:**

- NOTES:

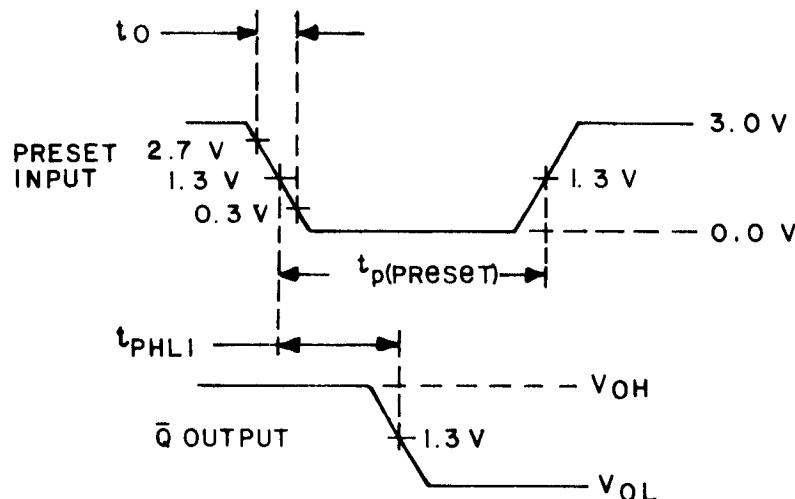
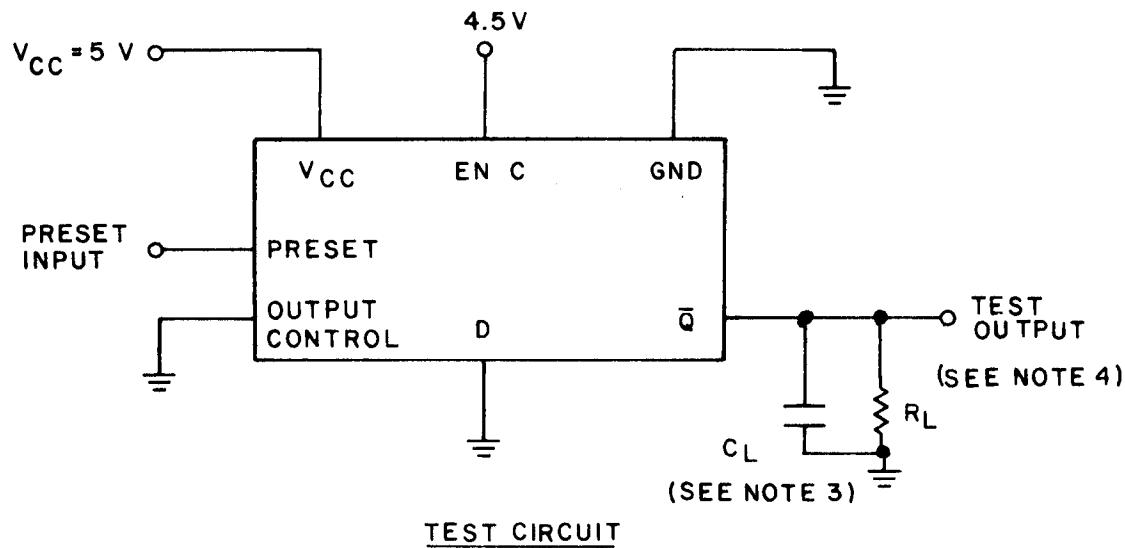
  1. Enable input pulse characteristics:  $t_0 = 6 \pm 1.5$  ns;  $t_p = 10$  ns; PRR  $\leq 1$  MHz;  
 $Z_{OUT} \cong 50\Omega$ .
  2. D input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_{setup} = 10$  ns;  $t_{hold} = 7$  ns;  
 $t_p = 17$  ns; PRR is 50% of Enable PRR;  $Z_{OUT} \cong 50\Omega$ .
  3.  $C_L = 50$  pF  $\pm 10\%$  (including jig and probe capacitance).
  4.  $R_I = 499\Omega \pm 1\%$ .

FIGURE 5. Data switching test circuit and waveforms (device type 03).

**NOTES:**

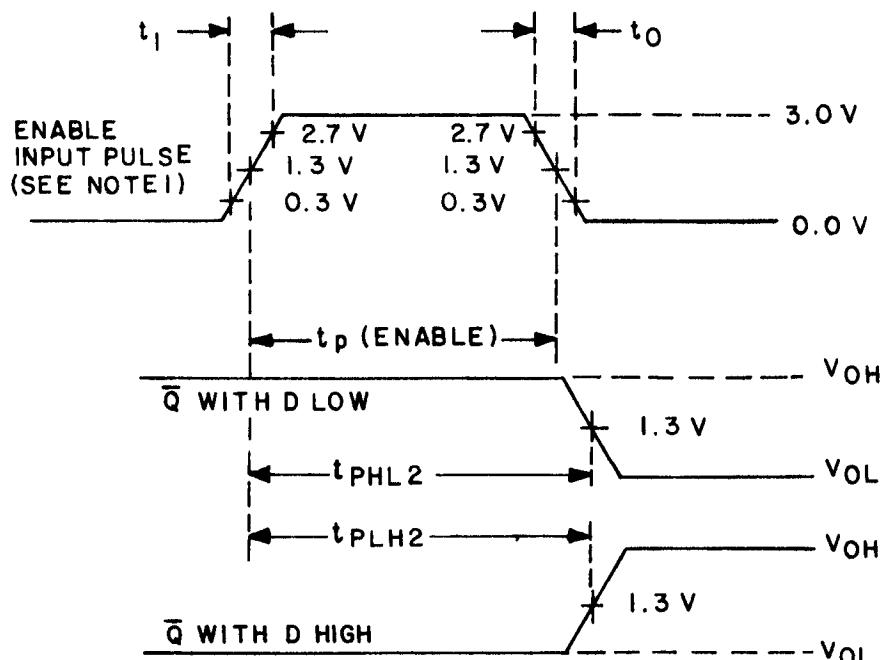
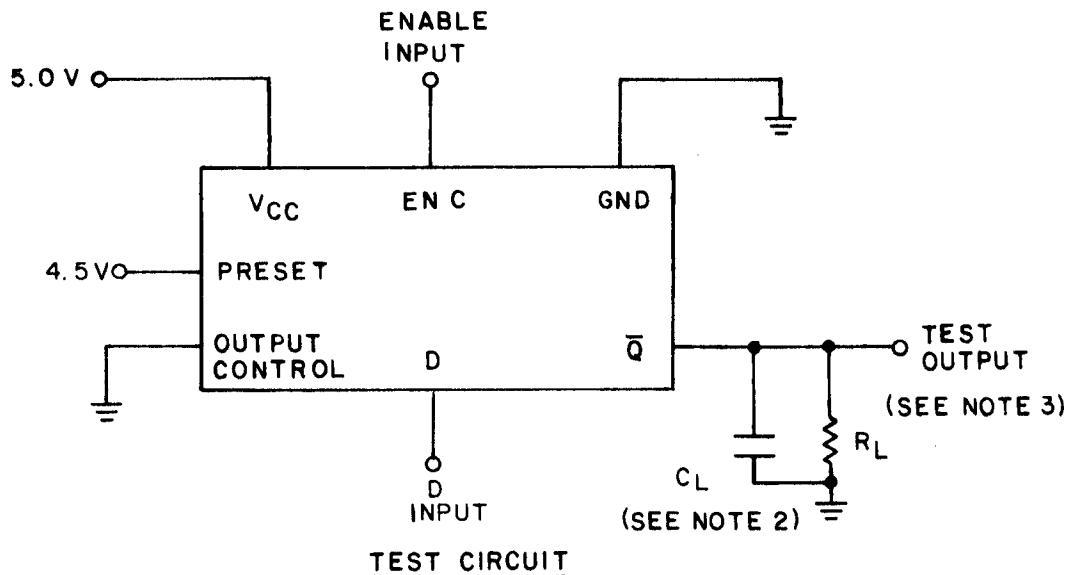
1. Output control input pulse characteristics:  $t_0 = t_1 = 6 \pm 1.5$  ns;  $t_p \geq 200$  ns; PRR  $\leq 1$  MHz;  $Z_{OUT} \cong 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = R_{L1} = 499\Omega \pm 1\%$ .

FIGURE 5. Tri-state switching test circuit and waveforms for device type 03.

**NOTES:**

1. Preset input dominates regardless of state of D input.
2. Preset input pulse characteristics:  $t_0 = 6 \pm 1.5 \text{ ns}$ ;  $t_p$  (preset) = 15 ns; PRR  $\leq 1 \text{ MHz}$ ;  $Z_{OUT} \approx 50\Omega$ .
3.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
4.  $R_L = 499\Omega \pm 1\%$ .

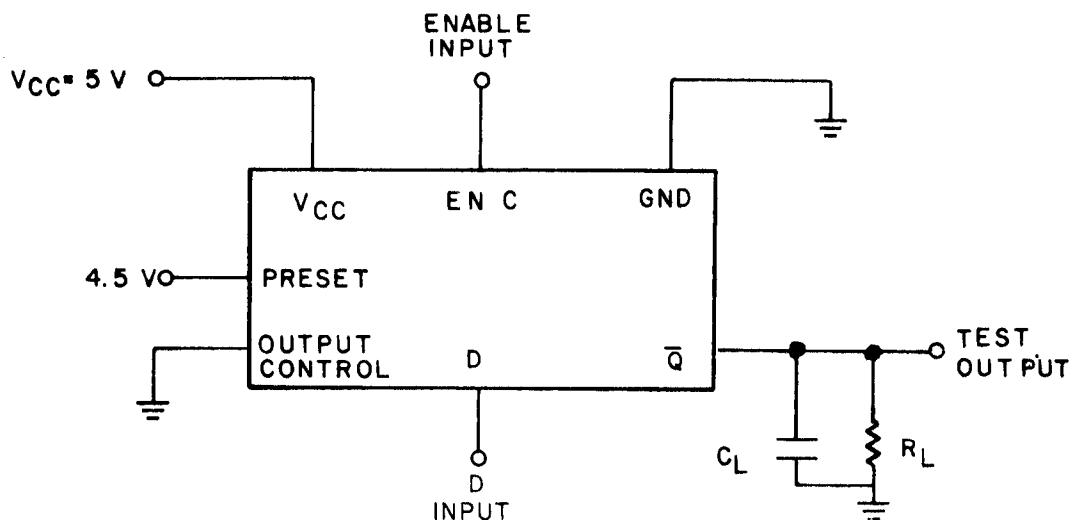
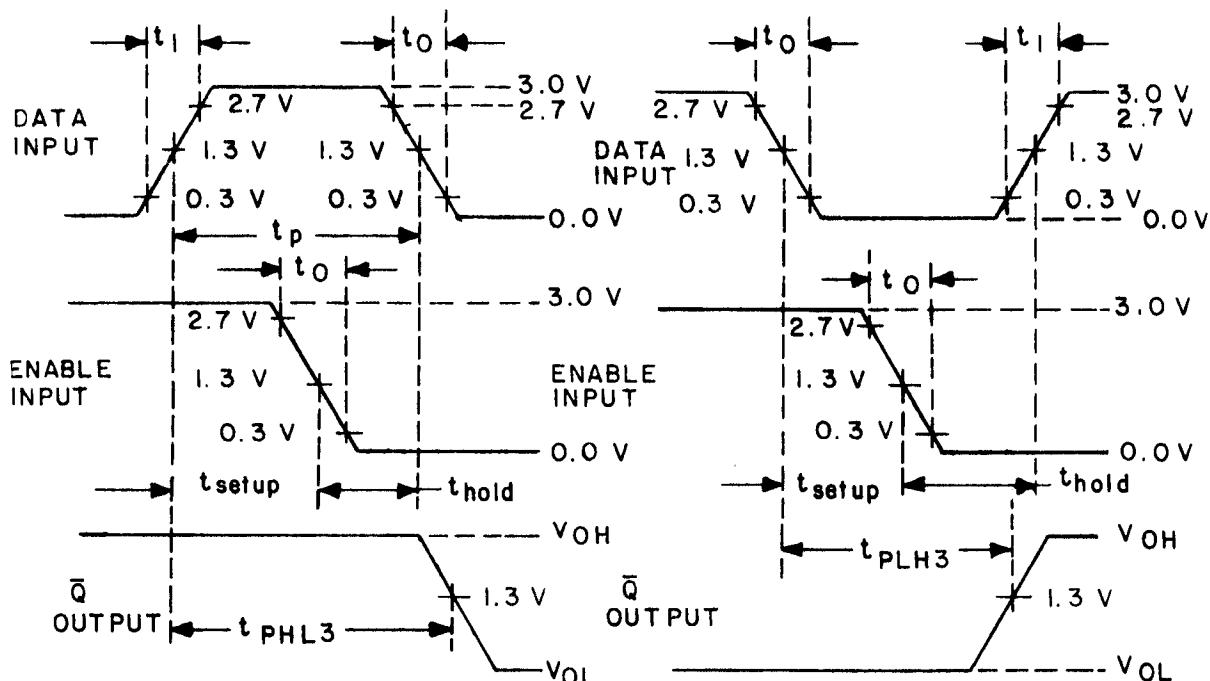
FIGURE 5. Preset switching test circuit and waveforms for device type 04.

VOLTAGE WAVEFORMS

## NOTES:

1. Enable input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_p$  (enable) = 15 ns; PRR  $\leq 1$  MHz;  $Z_{OUT} \leqq 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = 499\Omega \pm 1\%$ .

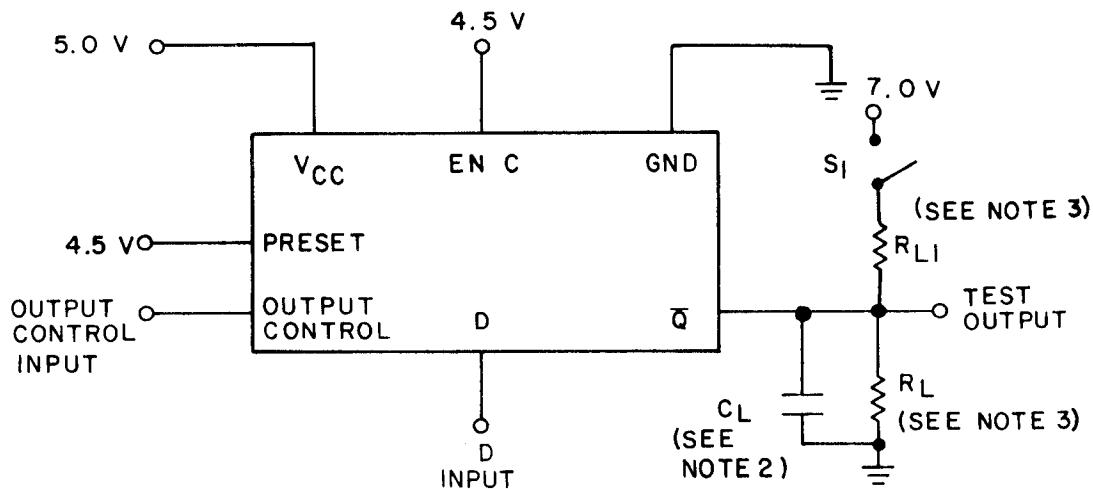
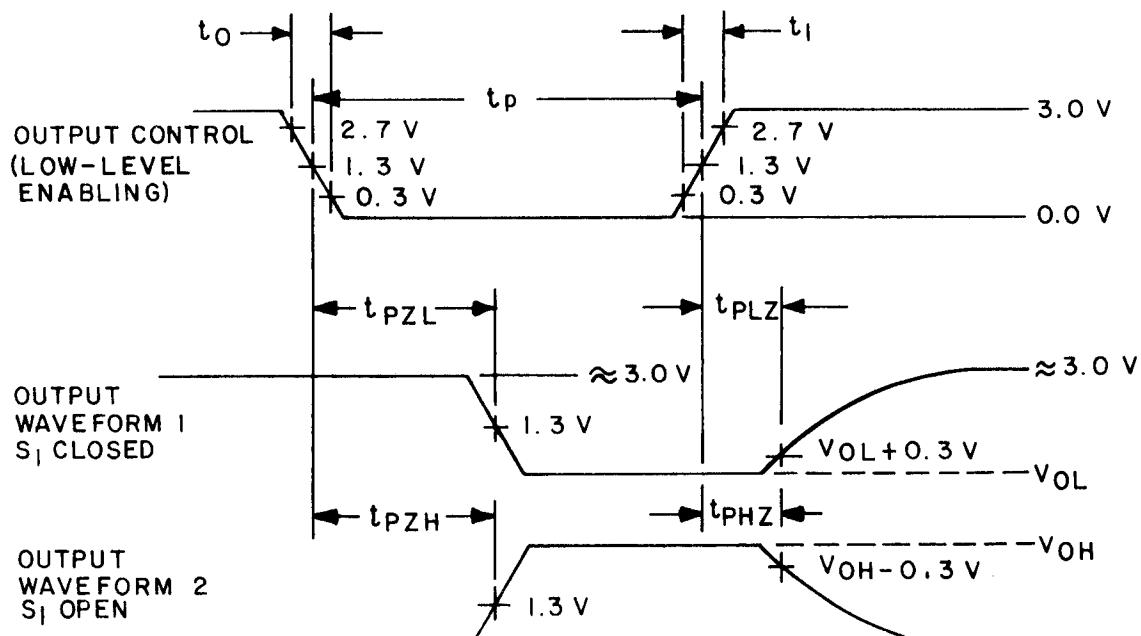
FIGURE 5. Enable switching test circuit and waveforms (device type 04).

TEST CIRCUITVOLTAGE WAVEFORMS

## NOTES:

1. Enable input pulse characteristics:  $t_0 = 6 \pm 1.5$  ns;  $t_p = 15$  ns; PRR  $\leq 1$  MHz;  $Z_{OUT} \geq 50\Omega$ .
2. D input pulse characteristics:  $t_1 = t_0 = 6 \pm 1.5$  ns;  $t_{setup} = 10$  ns;  $t_{hold} = 10$  ns;  $t_p = 20$  ns; PRR is 50% of enable PRR,  $Z_{OUT} \geq 50\Omega$ .
3.  $C_L = 50$  pF 10% (including jig and probe capacitance).
4.  $R_L = 499\Omega \pm 1\%$ .

FIGURE 5. Data switching test circuit and waveforms (device type 04).

TEST CIRCUITVOLTAGE WAVE FORMS

## NOTES:

1. Output control input pulse characteristics:  $t_0 = t_1 = 6 \pm 1.5 \text{ ns}$ ;  $t_p \geq 200 \text{ ns}$ ;  $\text{PRR} \leq 1 \text{ MHz}$ ;  $Z_{\text{OUT}} \approx 50\Omega$ .
2.  $C_L = 50 \text{ pF} \pm 10\%$  (including jig and probe capacitance).
3.  $R_L = R_{L1} = 499\Omega \pm 1\%$ .

FIGURE 5. Tri-state switching test circuit and waveforms for device type 04.

TABLE III. Group A inspection for device type 01.  
Terminal conditions (pins not designated may be high  $\geq 2.0$  V, low  $\leq 0.8$  V, or open).

Subgroup	Symbol	MIL-STD-883C Test Method	Cases												Measured Terminal Test Limits	Unit					
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	
1 $T_C = +25^\circ C$	I <sub>VOH</sub>	3006	1	0.8 V	2.0 V																V
		"	2	"	"	2.0 V															"
		"	3	"	"	"	2.0 V														"
		"	4	"	"	"	"	2.0 V													"
		"	5	"	"	"	"	"	2.0 V												"
		"	6	"	"	"	"	"	"	2.0 V											"
		"	7	"	"	"	"	"	"	"	2.0 V										"
		"	8	"	"	"	"	"	"	"	"	2.0 V									"
V <sub>OL</sub>	I <sub>OOL</sub>	3007	9	"	0.8 V	0.8 V															"
		"	10	"	"	"	0.8 V														"
		"	11	"	"	"	"	0.8 V													"
		"	12	"	"	"	"	"	0.8 V												"
		"	13	"	"	"	"	"	"	0.8 V											"
		"	14	"	"	"	"	"	"	"	0.8 V										"
		"	15	"	"	"	"	"	"	"	"	0.8 V									"
		"	16	"	"	"	"	"	"	"	"	"	0.8 V								"
V <sub>IC</sub>	I <sub>OIC</sub>	17	-18 mA	-18 mA	-18 mA	-18 mA	-18 mA	-18 mA	"												
		"	18	-18 mA	-18 mA	-18 mA	-18 mA	-18 mA	-18 mA	"											
		"	19	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	20	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	21	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	22	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	23	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	24	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I <sub>IL</sub>	I <sub>OIL</sub>	25	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	26	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	27	0.4 V	0.4 V	0.4 V	0.4 V	0.4 V	0.4 V	"											
		"	28	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	29	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	30	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	31	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	32	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I <sub>IH1</sub>	I <sub>OIH1</sub>	33	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	34	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	35	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	36	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	37	2.7 V	2.7 V	2.7 V	2.7 V	2.7 V	2.7 V	"											
		"	38	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	39	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	40	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I <sub>IH2</sub>	I <sub>OIH2</sub>	41	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	42	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	43	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	44	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	45	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	46	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	47	7.0 V	7.0 V	7.0 V	7.0 V	7.0 V	7.0 V	"											
		"	48	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
See footnotes at end of device type 01.	I <sub>IL</sub>	49	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	50	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	51	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	52	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	53	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	54	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	55	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
		"	56	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"

TABLE III. Group A inspection for device type 31 - Continued.  
Terminal conditions (pins not designated may be high  $\geq 2.0$  V, low  $\leq 0.8$  V, or open).

Subgroup	MIL-Gases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured Test limits	Unit
	Symbol 1ST-883.RS,2 method test no.																					Terminal Min Max	
1	$T_C = +25^\circ C$	3011	57	3ND	5.0 V	5.0 V																3/	
		2/	58	"	5.0 V	5.0 V															-15 -70	mA	
		60	59	"	5.0 V	5.0 V															30 -39		
		61	62	"	5.0 V	5.0 V															49 -59		
		63	64	"	5.0 V	5.0 V															60 -70		
																					80		
1.02A		65	5.0 V	2.0 V																	10 -20	A	
		66	"	2.0 V																	20 -30		
		67	"	2.0 V																	30 -40		
		68	69	"	2.0 V	2.0 V															40 -50		
		70	71	"	2.0 V	2.0 V															50 -60		
		72	"																		70 -80		
1.02L		73	5.0 V	0.8 V																	2.7 V		
		74	"	0.8 V																	2.7 V		
		75	76	"	0.8 V	0.8 V															2.7 V		
		77	78	"	0.8 V	0.8 V															2.7 V		
		79	80	"	0.8 V	0.8 V															2.7 V		
IC <sub>CH</sub>	3035	81	GND	5.0 V	19 mA																		
IC <sub>CL</sub>	"	82	GND	V <sub>CC</sub>																			
IC <sub>CZ</sub>	"	83	5.0 V	GND	V <sub>CC</sub>																		
																					27		
2																							
3																							
7.4/ $T_C = +25^\circ C$	Truth Table tests	3014	84	3	3	3	3	3	3	3	3	3	3	3	3	3	3	3	3	3	All outputs	S/	
		85	"	3	A	A	B	A	A	A	A	A	A	A	A	A	A	A	A	L			
		86	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	H			
		87	"	3	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	L			
		88	"	3	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	H			
		89	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	H			
		90	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	H			
		91	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	H			
		92	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	L			
		93	"	3	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	L			
		94	"	3ND	4.5 V	5.0 V																	
		95	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	10 -20		
		96	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	20 -30		
		97	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	40 -50		
		98	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	60 -70		
		99	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	80		
		100	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
8																							
9/ $T_C = +25^\circ C$	tPLH2 FF9	3003	93	3ND	4.5 V	5.0 V																	
		94	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	10 -20		
		95	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	20 -30		
		96	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	40 -50		
		97	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	60 -70		
		98	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	80		
		99	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
		100	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			

See footnotes at end of device type 31.

TABLE III. Group A inspection for device type 01 - continuec.  
Terminal conditions pins not designated may be high  $\geq 2.0$  V, low  $\leq 0.2$  V, or open.

Subgroup	Symbol	h <sub>L</sub>	h <sub>H</sub>	Test	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test Limits	Unit			
				no.	OC	ID	2D	3D	4D	5D	6D	7D	8D	9D	GND	TNC	8C	7C	6C	5C	4C	3C	2C	1C	V <sub>CC</sub>	Terminal TMIN	TMAX			
$T_c = 25^\circ C$	tpHL2	3003	101	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	1.0 V	INC to 10	6	19	ns		
		F19.5	102																							INC to 30				
			103																							INC to 40				
			104																							INC to 50				
			105																							INC to 60				
			106																							INC to 70				
			107																							INC to 80				
			108																											
	tpLH3		109		IN	OUT	1.0 to 10	2	14																					
			110																							2D to 30				
			111																							4D to 49				
			112																							5D to 59				
			113																							6D to 69				
			114																							7D to 79				
			115																							8D to 89				
			116																											
	tpHL3		117		IN	OUT	1.0 to 10	2	14																					
			118																							2D to 29				
			119																							3D to 39				
			120																							4D to 49				
			121																							5D to 59				
			122																							6D to 69				
			123																							7D to 79				
			124																							8D to 89				
	tpZH		125	IN	4.5 V	OUT	1.0C to 10	4	18																					
			126																							1.0C to 29				
			127																							1.0C to 39				
			128																							1.0C to 49				
			129																							1.0C to 59				
			130																							1.0C to 69				
			131																							1.0C to 79				
			132																							1.0C to 89				
	tpZL		133		GND	OUT	1.0C to 10	2	14																					
			134																							1.0C to 29				
			135																							1.0C to 39				
			136																							1.0C to 49				
			137																							1.0C to 59				
			138																							1.0C to 69				
			139																							1.0C to 79				
			140																							1.0C to 89				
	tpHZ		141		4.5 V	OUT	1.0C to 10	2	10																					
			142																							1.0C to 29				
			143																							1.0C to 39				
			144																							1.0C to 49				
			145																							1.0C to 59				
			146																							1.0C to 69				
			147																							1.0C to 79				
			148																							1.0C to 89				
	tpZL		149		GND	OUT	1.0C to 10	2	15																					
			150																							1.0C to 29				
			151																							1.0C to 39				
			152																							1.0C to 49				
			153																							1.0C to 59				
			154																							1.0C to 69				
			155																							1.0C to 79				
			156																							1.0C to 89				

See footnotes at end of device type 01.

TABLE III. Group A inspection for device type 301 - Continued.  
Terminal conditions (pins not designated may be high  $\geq 2.0$  V, low  $\leq 0.8$  V, or open).

Subgroup	MIL-Symbol	IS10-883RS2	Cases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test limits	Unit	
	Method	Test no.	Method	OC	10	20	30	40	50	60	70	80	GND	ENC	B0	7Q	5Q	4Q	3Q	2Q	1Q	VCC	Terminal Min	Max			
10	tpPH2																							8	27	ns	
$T_C = +125^\circ C$	tpHL2																							4	20	"	
	tpHL3																							2	15	"	
	tpHL3																							2	15	"	
	tpZH																							4	21	"	
	tpZL																							4	21	"	
	tpHZ																							2	12	"	
	tpLZ																							2	18	"	
11																											
$T_C = -55^\circ C$																											

11. Same tests, terminal conditions, and limits as for subgroup 10, except  $T_C = -55^\circ C$ .

1/  $I_{IL}$  limits shall be as follows:

Test	A	B	C
$I_{IL}$	0.7-200	0.7-100	0.7-200

2/ Method 3011 shall be used, except the output voltage shall be as specified herein, and the output current shall be operating rather than short-circuit current. The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current  $I_{OS}$ .

3/  $I_0$  limits shall be as follows:

Test	A	B	C
$I_0$	-30/-112	-15/-110	-70/-110

4/ Tests shall be performed in sequence, attributes data only.

5/ Outputs shall be high  $\geq 1.5$  V, low  $\leq 0.8$  V.

TABLE III. Group A inspection for device type 02.  
Terminal conditions (pins not designated may be high  $\pm 2.0$  V, low  $\pm 0.8$  V, or open).

Subgroup	Symbol	MIL-Cases	Test Limits																					
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured terminal	Unit
$T_C = 25^\circ C$	$V_{OH}$	3006	1	0.8 V	2.4 V																			
			2	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			3	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			4	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			5	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			6	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			7	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			8	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
$V_{OL}$	3007	10	9	-	2.0 V	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			11	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			12	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			13	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			14	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			15	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			16	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			17	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
$V_{IC}$	18	17	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			19	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			20	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			21	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			22	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			23	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			24	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			25	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
$I_{IL}$	3009	27	28	0.4 V																				
			29	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			30	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			31	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			32	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			33	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			34	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			35	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
$I_{IH1}$	3010	37	38	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			39	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			40	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			41	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			42	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			43	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			44	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			45	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
$I_{IH2}$	47	48	49	7.0 V																				
			50	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			51	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			52	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			53	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			54	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			55	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			56	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	

See footnotes at end of device type 02.

TABLE III. Group A inspection for device type 02 - Continued.  
Terminal conditions (pins not designated may be high  $\geq 22.0$  V, low  $\leq 0.8$  V, or open).

Subgroup	Symbol	MIL-Cases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test	limits			
		Symbol S10-9831A, S12	Test no.	T <sub>C</sub>	10	20	30	40	50	60	70	80	GND	ENC	8Q	7Q	6T	5Q	4Q	3Q	2Q	1Q	V <sub>CC</sub>	Terminal	Min	Max		
1 T <sub>C</sub> =+25°C	I <sub>OZL</sub>	3011	57	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	15.0 V								15.0 V	5.5 V	-15	70	mA	
		"	58	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	35	40	
		"	60	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	50	60	
		"	61	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	60	70	
		"	62	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	60	70	
		"	63	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	60	70	
		"	64	"	"	"	"	"	"	"	"	"	"	"	"									2.25 V	2.25 V	60	70	
	I <sub>OZH</sub>		65	15.0 V	0.8 V		0.8 V		0.8 V		0.8 V													2.7 V	2.7 V	10	20	A
			66	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	35	40	
			67	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	50	60	
			68	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	60	70	
			69	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	60	70	
			70	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	60	70	
			71	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	60	70	
			72	"	"	"	"	"	"	"	"	"	"	"	"									2.7 V	2.7 V	60	70	
	I <sub>OZL</sub>		73	"	12.0 V																			10.4 V	10.4 V	15	20	
			74	"	"	2.0 V																		10.4 V	10.4 V	20	30	
			75	"	"	"	2.0 V																	10.4 V	10.4 V	35	40	
			76	"	"	"	"	2.0 V																10.4 V	10.4 V	50	60	
			77	"	"	"	"	"	2.0 V															10.4 V	10.4 V	60	70	
			78	"	"	"	"	"	"	2.0 V														10.4 V	10.4 V	60	70	
			79	"	"	"	"	"	"	"	2.0 V													10.4 V	10.4 V	60	70	
			80	"	"	"	"	"	"	"	"	2.0 V												10.4 V	10.4 V	60	70	
	I <sub>OCH</sub>		3035	81	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	"									"	V <sub>CC</sub>	15	mA	
			"	82	GND	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	"	V <sub>CC</sub>	24	mA											
	I <sub>OCL</sub>		"	83	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	"	V <sub>CC</sub>	27	mA		
2																												
3																												
4																												
7/4 T <sub>C</sub> =+25°C	Truth table tests	3014	84	3	A	A	A	A	B	A	B	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	85	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	86	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	87	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	88	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	89	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	90	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	91	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
		"	92	3	A	A	A	A	A	A	A	A	A	GND	A	L	H	L	H	L	H	L	5.0 V	All outputs	5/ 4			
8																												
9 T <sub>C</sub> =+25°C	tPLH2 Fig. 5	3003	93	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	"	"	"	"	"	"	"	"	OUT	OUT	8		
		"	94	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	95	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	96	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	97	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	98	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	99	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		
		"	100	"	"	"	"	"	"	"	"	"	"	"	"									OUT	OUT	22		

See footnotes at end of device type 02.

TABLE III. Group A inspection for device type 02 - Continued.  
Terminal conditions (pins not designated may be high  $\geq 2.0$  V, low  $\leq 0.8$  V, or open).

Subgroup	Symbol	MIL-STD-883 Cases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured Test limits	
			Test no.	DC	1D	2D	3D	4D	5D	6D	7D	8D	GND	ENC	8Q	7Q	6Q	5Q	4Q	3Q	2Q	1Q	VCC	Terminal Min Max
$T_C = 25^\circ C$	$t_{PHL2}$	3003	101	GND	4.5 V	4.5 V							GND	IN									OUT	OUT
		Fig. 5	102																				15.0 V	ENC to 10.0 V
			103																				ENC to 20.0 V	ns
			104																				ENC to 30.0 V	
			105																				ENC to 40.0 V	
			106																				ENC to 50.0 V	
			107																				ENC to 60.0 V	
			108																				ENC to 80.0 V	
	$t_{PLH3}$		109		IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	OUT	OUT
			110																				10.0 V	15.0 V
			111																				20.0 V	25.0 V
			112																				30.0 V	35.0 V
			113																				40.0 V	45.0 V
			114																				50.0 V	55.0 V
			115																				60.0 V	65.0 V
			116																				70.0 V	75.0 V
																							80.0 V	85.0 V
	$t_{PHU3}$		117		IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	IN	OUT	OUT
			118																				10.0 V	12.0 V
			119																				20.0 V	25.0 V
			120																				30.0 V	35.0 V
			121																				40.0 V	45.0 V
			122																				50.0 V	55.0 V
			123																				60.0 V	65.0 V
			124																				70.0 V	75.0 V
																							80.0 V	85.0 V
	$t_{PZH}$		125		IN	GND	GND	GND	GND	GND	GND	GND	GND	GND									OUT	OUT
			126																				10.0 V	12.0 V
			127																				20.0 V	25.0 V
			128																				30.0 V	35.0 V
			129																				40.0 V	45.0 V
			130																				50.0 V	55.0 V
			131																				60.0 V	65.0 V
			132																				70.0 V	75.0 V
																							80.0 V	85.0 V
	$t_{PZL}$		133			4.5 V	4.5 V																OUT	OUT
			134																				10.0 V	12.0 V
			135																				20.0 V	25.0 V
			136																				30.0 V	35.0 V
			137																				40.0 V	45.0 V
			138																				50.0 V	55.0 V
			139																				60.0 V	65.0 V
			140																				70.0 V	75.0 V
	$t_{PHZ}$		141																				10.0 V	12.0 V
			142																				20.0 V	25.0 V
			143																				30.0 V	35.0 V
			144																				40.0 V	45.0 V
			145																				50.0 V	55.0 V
			146																				60.0 V	65.0 V
			147																				70.0 V	75.0 V
			148																				80.0 V	85.0 V

See footnotes at end of device type 02.

TABLE III. Group A inspection for device type 02 - Continued.  
Terminal conditions (pins not designated may be high ≥2.0 V, low ≤0.8 V, or open).

Subgroup	Symbol	ML-Cases method no.	Test												Measured				Test Limits				
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Terminal Unit
9 $T_C = +25^\circ C$	TPZL	3003	149	In	4.5 V	GND	8Q	7Q	6Q	5Q	4Q	3Q	2Q	1Q	V <sub>CC</sub>								
	TPZL	150	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	151	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	152	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	153	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	154	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	155	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	TPZL	156	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
10 $T_C = +125^\circ C$	TPHL2																						
	TPHL2																						
	TPHL3																						
	TPHL3																						
	TPZH																						
	TPZL																						
	TPHZ																						
	TPZL																						
11 $T_C = -55^\circ C$																							

Same tests, terminal conditions, and limits as for subgroup 10, except  $T_C = -55^\circ C$ .

1/  $I_{IL}$  limits shall be as follows:

Test	Limits in $\mu A$ for circuit		
	A	B	C
T <sub>IL</sub>	3/-100	3/-100	0/-200

2/ Method 3011 shall be used, except the output voltage shall be as specified herein, and the output current shall be operating rather than short-circuit current. The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current  $I_{OS}$ .

3/  $I_O$  limits for circuit C shall be  $-70$  to  $-110$  mA

4/ Tests shall be performed in sequence, attributes data only.

5/ Outputs shall be high ≥1.5 V, low ≤1.5 V.

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated) may be high  $\geq 2.0$  V, or low  $< 0.8$  V, or open.

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type U<sub>2</sub> - Continued.  
Terminal conditions (pins not designated) may be high  $\frac{1}{2}$ .0 V. or low  $\frac{1}{2}$ .8 V. or open.

TABLE III. Group A inspection for de  
Terminal conditions (pins not designated may be

See footnotes at end of device type 0.

TABLE III. Group A inspection for device type U5 - Continued  
Terminal conditions (pins not designated) may be high  $\frac{22.0}{22.0}$  V, or low  $\frac{0.8}{0.8}$  V, or open).

same tests, terminal conditions, and limits as for subgroup 1, except  $T_c = +125^\circ\text{C}$  and VIC tests are omitted.

$T$	$\frac{S_2}{S_1}$	Truth table tests	-0.4	108	A	B	CBD	A	S <sub>UV</sub>	All outputs	$S_f$
TC = +25°C	-	-	-	109	A	B	-	-	-	-	-
	-	-	-	110	A	B	-	-	-	-	-
	-	-	-	111	A	B	-	-	-	-	-
	-	-	-	112	A	B	-	-	-	-	-
	-	-	-	113	A	B	-	-	-	-	-
	-	-	-	114	A	B	-	-	-	-	-
	-	-	-	115	A	B	-	-	-	-	-
	-	-	-	116	A	B	-	-	-	-	-
	-	-	-	117	A	B	-	-	-	-	-
	-	-	-	118	A	B	-	-	-	-	-
	-	-	-	119	A	B	-	-	-	-	-
	-	-	-	120	A	B	-	-	-	-	-
	-	-	-	121	A	B	-	-	-	-	-
	-	-	-	122	A	B	-	-	-	-	-
	-	-	-	123	A	B	-	-	-	-	-
	-	-	-	124	A	B	-	-	-	-	-

Same tests, terminal conditions, and limits as for subaru 7 percent Tr = +125.7 and -65.1

See footnotes at end of device type list.

TABLE III. Group A inspection  
for device type 03. Continued.  
Terminal conditions (pins not designated  
may be high,  $\geq 5.0$  V, or low  $\leq 0.8$  V, or open).

Subgroup	Symbol	Case no.	Case 3 1/2 Cases 1 2 3 4 5 6 7 9 10 11 12 13 14												Case 16 17 18 19 20 21 23 24 25 26 27 28								Measured terminal		Limits			
			MIL-STD-883	Method	Test	100%	101%	102%	103%	104%	201%	202%	203%	204%	GND	ZTCX	HZC	2Q3	2Q2	2Q1	1Q4	1Q3	1Q2	1Q1	EMIC	T <sub>CC</sub>	Min	Max
$T_c = +25^\circ C$	TPU3	3003	149	4.5 V	GND	IN	IN	IN	IN	IN	IN	IN	IN	IN	GND	4.5 V	IN	IN	IN	IN	OUT	OUT	OUT	OUT	IN	5.0 V	101	2
	Fig. 5	150	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	102	ns	
		151	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	103	ns	
		153	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	104	ns	
		154	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	105	ns	
		155	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	106	ns	
		156	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	107	ns	
		157	4.5 V	GND	IN	IN	GND	4.5 V	IN	IN	IN	IN	OUT	OUT	OUT	OUT	IN	5.0 V	101	2								
		158	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	102	ns	
		159	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	103	ns	
		160	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	104	ns	
		161	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	105	ns	
		162	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	106	ns	
		163	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	107	ns	
		164	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	108	ns	
		165	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	GND	4.5 V	IN	IN	IN	IN	OUT	OUT	OUT	OUT	OUT	4.5 V	101	4
		166	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	102	ns	
		167	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	103	ns	
		168	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	104	ns	
		169	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	105	ns	
		170	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	106	ns	
		171	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	107	ns	
		172	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	108	ns	
		173	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	GND	4.5 V	IN	IN	IN	IN	OUT	OUT	OUT	OUT	OUT	4.5 V	101	3
		174	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	102	ns	
		175	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	103	ns	
		176	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	104	ns	
		177	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	105	ns	
		178	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	106	ns	
		179	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	107	ns	
		180	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	108	ns	
		181	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	GND	4.5 V	IN	IN	IN	IN	OUT	OUT	OUT	OUT	OUT	4.5 V	101	2
		182	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	102	ns	
		183	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	103	ns	
		184	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	104	ns	
		185	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	105	ns	
		186	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	106	ns	
		187	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	107	ns	
		188	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	108	ns	

See footnotes at end of device type 03.

TABLE III. Group A inspection for device type G<sub>3</sub> - Continued.  
Terminal conditions (pins not designated) may be high >2.6 V, or low <0.8 V, or open)

תְּמִימָנָה וְעַמְּדָה תְּמִימָנָה וְעַמְּדָה

We show 30.11 shall be used, except the output voltage shall be as specified herein, and the output current shall be operating rather than short-circuit current. The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current.

4/ 16 limits for circuit C shall be -70 to -110 mA.  
5/ Tests shall be performed in sequence, attributes data only.

TABLE III. Group A inspection for device type OA  
Terminal conditions (pins not designated may be high 2.70 V, or low 0.8 V, or open).

Subgroup	Symbol	MIL-STD-883 Test No.	Case k <sub>L</sub>	Test no.	Terminal conditions (pins not designated may be high 2.70 V, or low 0.8 V, or open).												Measured terminal	Unit									
					2	3	4	5	6	7	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	
T <sub>C</sub> = 25°C	V <sub>OH</sub>	3006	1	2.0 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	0.8 V	2.0 V	2.0 V	-1.0 mA							
		-	2	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	3	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	4	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	5	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	6	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	7	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	8	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	9	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	10	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	11	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	12	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	13	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	14	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	15	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	16	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	17	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	18	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	19	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	20	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	21	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	22	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	23	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	24	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	25	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	26	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	27	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	28	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	29	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	30	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	31	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	32	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	33	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	34	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	35	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	36	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	37	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	38	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	39	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	40	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	41	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	42	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	43	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	44	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	45	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	46	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	47	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	48	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	49	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	50	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	51	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
		-	52	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-

See footnotes at end of device type OA.

TABLE III. Group A inspection for device type 64 - Continued.  
Terminal conditions (pins not designated may be high  $\geq 2.0$  V, or low  $\leq 0.8$  V, or open).

See footnotes at end of device type 04.

TABLE III. Group A inspection for device type 04 - continued.  
Terminal conditions (pins not designated) may be high  $2 \times 0$  V, or low  $0.8 V$ , or open.

Subgroup	Symbol	MIL-STD-883 Cases	Case 1/1	Test												Measured terminal																		
				1.1	1.2	1.3	1.4	1.5	1.6	1.7	1.8	1.9	1.10	1.11	1.12	1.13	1.14	1.15	1.16	1.17	1.18	1.19	1.20	1.21	1.22	1.23	1.24	1.25	1.26	1.27	1.28			
$T_C = +25^\circ C$	IICH	.005	105	5.0 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND			
	IICL	*	106	GND	*	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V	5.0 V												
	IICZ	*	107	*	15.0 V	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	
2	Same tests, terminal conditions, and limits as for subgroup 1, except $T_C = +25^\circ C$ and VIC tests are omitted.																																	
3	Same tests, terminal conditions, and limits as for subgroup 1, except $T_C = -55^\circ C$ and VIC tests are omitted.																																	
7	5/	Truth table tests	.004	108	A	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B			
			*	109	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	110	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	111	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	112	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	113	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	114	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	115	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	116	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	117	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	118	B	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	119	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	120	B	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	121	A	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	122	A	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	123	B	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
8	5/	Same tests, terminal conditions, and limits as for subgroup 1, except $T_C = -125^\circ C$ and $-55^\circ C$ .																																
9	5/	$T_{ph1}$	.005	124	In	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND													
			*	125	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	126	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	127	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	128	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	129	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	130	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
			*	131	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
10	5/	$T_{ph2}$	.005	132	4.5 V	GND	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V	4.5 V											
			*	133	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	134	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	135	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	136	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	137	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	138	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	139	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	140	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	141	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	142	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	143	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	144	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
			*	145	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
			*	146	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
			*	147	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-

See footnotes at end of device type 04.

TABLE III. Group A insertion for device type 04 - Continued  
for device type 04 - Continued may be high  $\geq 2.0 \text{ V}$ , or low  $\leq 0.8 \text{ V}$ , or open.

Subgroup	MIL-STD-BAB Test No.	Test Method	Terminals	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	Measured terminal	Unit				
$T_c = +25^\circ\text{C}$	148	4.5 V	GND	IN	IN	5.0 V	101 to 103	3																													
	145	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	20 ns						
	151	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-						
	152	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-						
	153	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-						
	154	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-						
	155	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-						
$T_{PH3}$	156	4.5 V	GND	IN	IN	IN	101 to 103	12																													
	157	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	158	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	159	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	160	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	161	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	162	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	163	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
$T_{PH3}$	164	4.5 V	IN	GND	IN	IN	IN	4.5 V	101 to 103	5																											
	165	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	166	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	167	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
	171	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-					
$T_{PZL}$	172	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	101 to 103	18
	173	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	174	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	175	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	176	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	177	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	178	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	179	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
$T_{PZL}$	180	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	4.5 V	IN	101 to 103	9
	181	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	182	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	183	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	184	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	185	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	186	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				
	187	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-				

See footnotes at end of device type 04.

TABLE III. Group A inspection for device type 04 - Continued.  
Terminal conditions (pins not designated) may be high 22.0 V, or low 0.6 V, or open.

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These last references are M/C.

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Method 4011 shall be used, except the output voltage shall be as specified herein, and the output current shall be operating rather than short-circuit current. The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current.

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5/ Tests shall be performed in sequence, after the test of smaller size.

## 6. NOTES

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

6.2 Ordering data. The acquisition document should specify the following:

- a. Complete part number (see 1.2).
  - b. Requirements for delivery of one copy of the quality conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
  - c. Requirements for certificate of compliance, if applicable.
  - d. Requirements for notification of change of product or process to the contracting activity in addition to notification to the qualifying activity, if applicable.
  - e. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.
  - f. Requirements for product assurance options.
  - g. Requirements for special carriers, lead lengths, or lead forming, if applicable, these requirements shall not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
  - h. Requirements for "JAN" marking.

6.3 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-M-38510, MIL-STD-1331, and as follows:

**6.4 Logistic support.** Lead materials and finishes (see 3.3), are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), and lead material and finish C (see 3.3). Longer lead lengths and lead forming shall not affect the part number.

**6.5 Substitutability.** The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information shall not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-M-38510.

<u>Military device type</u>	<u>Generic-industry type</u>
01	54ALS573
02	54ALS580
03	54ALS873
04	54ALS880

6.6 Manufacturers' designations. Manufacturers' circuits which form a part of this specification are designated with an "X" as shown in table IV herein.

TABLE IV. Manufacturers' designations.

Device type	Circuits		
	A Texas Instruments	B Motorola Inc.	C National Semiconductor Corp.
01	X		
02	X		
03	X		
04	X		

## Custodians:

Army - ER  
Navy - EC  
Air Force - 17

Preparing activity:  
Air Force - 17

## Review activities:

Army - AR, MI  
Navy - OS, SH, TD  
Air Force - 11, 19, 85, 99  
DLA - ES

(Project 5962-1010)

## User activities:

Army - SM  
Navy - AS, CG, MC

Agent:  
DLA - ES